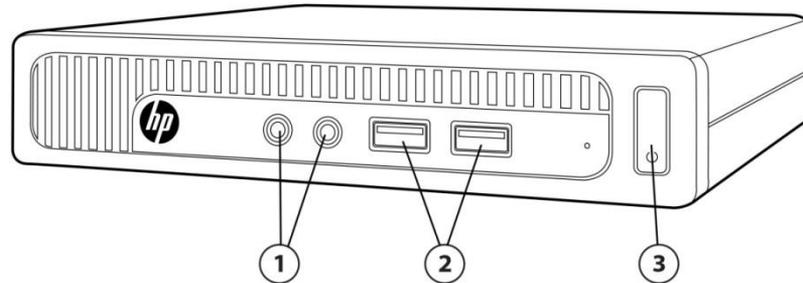


Overview

HP EliteDesk 705 G1 Desktop Mini Business PC



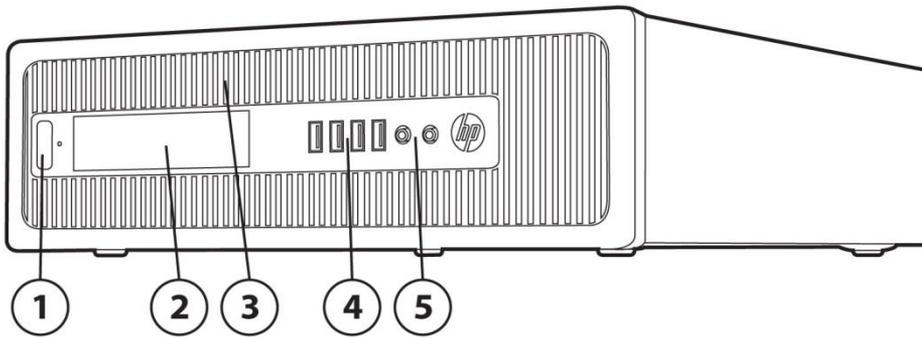
1. 3.5mm headphone output and microphone jacks
2. (2) Front USB 3.0 ports
3. Power button and PC status LED

Not Shown

- | | |
|----------|--|
| Slots | (1) internal M.2 connector for optional wireless NIC
(1) internal M.2 connector for optional SSD drive |
| Bays | (1) 2.5" internal storage drive bay |
| Rear I/O | (2) USB 3.0 ports
(2) USB 2.0 ports
(1) VGA video port; (2) DisplayPort with multi-stream video ports
(1) RJ-45 network connector
3.5mm audio out jack |
| VESA | Support for VESA 100 mounting system on bottom of PC chassis |

Overview

HP EliteDesk 705 G1 Small Form Factor Business PC



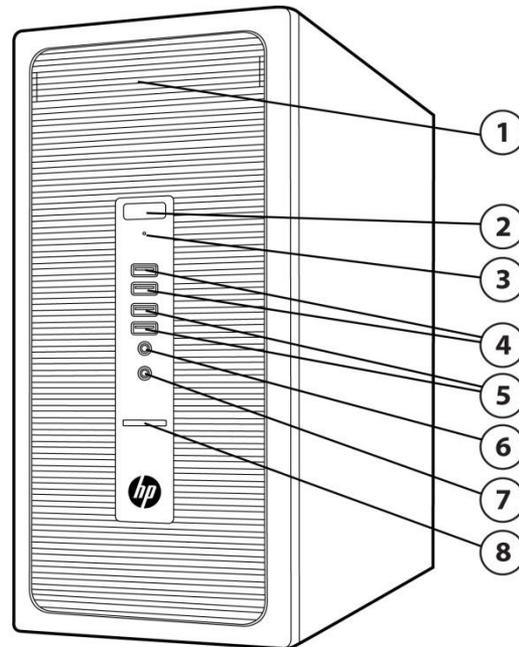
1. Power button and PC status LED
2. 3.5" external drive bay; used for installing a Media Card Reader or 2nd data storage drive
3. Slim drive bay supporting an optical disk drive (located behind removable bezel)
4. (2) USB 3.0 ports, (2) USB 2.0 ports
5. 3.5mm headphone output and microphone jack

Not Shown

- Slots (2) PCI Express x16 graphics connectors; one wired as a x4
(2) PCI Express x1 accessory connectors
- Bays (1) 2.5" internal storage drive bay
(1) 3.5" internal storage drive bay
- Rear I/O (2) USB 3.0 ports; (4) USB 2.0 ports
(1) VGA video port; (2) DisplayPort with multi-stream video ports
(1) RJ-45 network connector
(1) RS-232 serial port
3.5mm audio in/out jacks
PS/2 keyboard and mouse ports

Overview

HP EliteDesk 705 G1 Microtower Business PC



1. Slim drive bay supporting an optical disk drive (located behind removable bezel)
2. Power button
3. PC status LED
4. (2) USB 2.0 ports
5. (2) USB 3.0 ports (charging port)
6. 3.5mm headphone output
7. Microphone jack
8. SD Card Reader bay

Not Shown

- Slots (2) PCI Express x16 graphics connectors; one wired as a x4
(2) PCI Express x1 accessory connectors
- Bays (1) Slim optical drive bay
(2) 3.5" internal storage drive bays
- Rear I/O (2) USB 3.0 ports; (4) USB 2.0 ports
(1) VGA video port; (2) DisplayPort with multi-stream video ports
(1) RJ-45 network connector
(1) RS-232 serial port
3.5mm audio in/out jacks
PS/2 keyboard and mouse ports

Overview

AT A GLANCE

- Choice of three chassis form factors: Desktop Mini, Small Form Factor and Microtower
- PC chassis and all internal components and modules are manufactured with low halogen content
- HP developed and engineered UEFI BIOS supporting security, manageability and software image stability
- DDR3 Synchronous Dynamic Random Access Memory (SDRAM)
- Multi-independent monitor support via VGA and dual digital DisplayPort video interfaces with multi-stream
- DTS Studio Sound audio management software
- Standard and high efficiency energy saving power supply options
- SFF and MT models can be configured with dual data drives in a RAID
- ENERGY STAR® qualified and certified EPEAT® Gold models
- Guaranteed lengthy purchase lifecycles and image stability

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Standard Features and Configurable Components

OPERATING SYSTEMS

Preinstalled When Purchased

Windows 8.1 Pro (64-bit)*

Windows 8.1 (64-bit)*

Windows 7 Professional (32-bit)*

Windows 7 Professional (64-bit)*

Windows 7 Professional (32-bit) (available through downgrade rights from Windows 8.1 Pro)**

Windows 7 Professional (64-bit) (available through downgrade rights from Windows 8.1 Pro)**

FreeDOS 2.0

Ubuntu Linux (64-bit)***

*Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows functionality. See <http://www.microsoft.com>.

**This system is preinstalled with Windows 7 Professional software and also comes with a license and media for Windows 8.1 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

***Not all features are supported in Ubuntu Linux.

CHIPSET

AMD® D4 Chipset

PROCESSORS

AMD Quad-Core A10 APU with AMD Radeon™ HD Graphics*

AMD Quad-Core A10 PRO-7850B Accelerated Processor with AMD Radeon™ R7 Series
 Up to 4 GHz Max. Boost Frequency (3.7 GHz base frequency)
 4 MB L2 cache, 4 cores, 8 Graphics Core Next Cores
 Discrete-Class Graphics
 Supports DDR3 memory up to 2133 MT/s data rate
 Supports AMD® DASH 1.1 Technologies

DM

SFF

MT

X

X

AMD Quad-Core A10 PRO-7800B Accelerated Processor with AMD Radeon™ R7 Series
 Up to 3.9 GHz Max. Boost Frequency (3.5 GHz base frequency)
 4 MB L2 cache, 4 cores, 8 Graphics Core Next Cores
 Discrete-Class Graphics
 Supports DDR3 memory up to 2133 MT/s data rate
 Supports AMD® DASH 1.1 Technologies

X

X

AMD Quad-Core A10 PRO-6800B Accelerated Processor with AMD Radeon™ HD 8670D
 Up to 4.4 GHz Max. Boost Frequency (4.1 GHz base frequency)
 4 MB L2 cache, 4 cores, 384 Radeon™ Cores 2.0
 Discrete-Class Graphics
 Supports DDR3 memory up to 2133 MT/s data rate
 Supports AMD® DASH 1.1 Technologies

X

X

AMD Quad-Core A8 APU with AMD Radeon™ HD Graphics*

DM

SFF

MT



Standard Features and Configurable Components

<p>AMD Quad-Core A8 PRO-7600B Accelerated Processor with AMD Radeon™ R7 Series Up to 3.8 GHz Max. Boost Frequency (3.1 GHz base frequency) 4 MB L2 cache, 4 cores, 6 Graphics Core Next Cores Discrete-Class Graphics Supports DDR3 memory up to 2133 MT/s data rate Supports AMD® DASH 1.1 Technologies</p>	X	X	X
<p>AMD Quad-Core A8-6500B Accelerated Processor with AMD Radeon™ HD 8570D Up to 4.1 GHz Max. Boost Frequency (3.5 GHz base frequency) 4 MB L2 cache, 4 cores, 256 Radeon™ Cores 2.0 Discrete-Class Graphics Supports DDR3 memory up to 1866 MT/s data rate Supports AMD® DASH 1.1 Technologies</p>		X	X
<p>AMD Dual-Core A6 APU with AMD Radeon™ HD Graphics*</p> <p>AMD Dual-Core A6 PRO – 7400B Accelerated Processor with AMD Radeon™ R5 Series Up to 3.9 GHz Max. Boost Frequency (3.5 GHz base frequency) 1 MB L2 cache, 2 cores, 4 Graphics Core Next Cores Discrete-Class Graphics Supports DDR3 memory up to 1866 MT/s data rate Supports AMD® DASH 1.1 Technologies</p>	<u>DM</u>	<u>SFF</u>	<u>MT</u>
<p>AMD Dual-Core A6 – 6420B Accelerated Processor with AMD Radeon™ HD 8470D Up to 4.2 GHz Max. Boost Frequency (4 GHz base frequency) 1 MB L2 cache, 2 cores, 192 Radeon™ Cores 2.0 Discrete-Class Graphics Supports DDR3 memory up to 1866 MT/s data rate Supports AMD® DASH 1.1 Technologies</p>		X	X
<p>AMD Dual-Core A4 APU with AMD Radeon™ HD Graphics*</p> <p>AMD Dual-Core A4 PRO – 7350B Accelerated Processor with AMD Radeon™ R5 Series Up to 3.8 GHz Max. Boost Frequency (3.4 GHz base frequency) 1 MB L2 cache, 2 cores, 3 Graphics Core Next Cores Discrete-Class Graphics Supports DDR3 memory up to 1866 MT/s data rate Supports AMD® DASH 1.1 Technologies</p>	<u>DM</u>	<u>SFF</u>	<u>MT</u>
<p>AMD Dual-Core A4 PRO – 7300B Accelerated Processor with AMD Radeon™ HD 8470D Up to 4.2 GHz Max. Boost Frequency (3.9 GHz base frequency) 1 MB L2 cache, 2 cores, 3 Graphics Core Next Cores Discrete-Class Graphics Supports DDR3 memory up to 1866 MT/s data rate Supports AMD® DASH 1.1 Technologies</p>		X	X

*Multi-Core is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. 64-bit computing system required. Performance will vary depending on your hardware and software configurations. AMD's numbering is not a measurement of higher performance.



Standard Features and Configurable Components

GRAPHICS

System Integrated Graphics

	<u>DM</u>	<u>SFF</u>	<u>MT</u>
AMD Radeon HD Graphics (integrated on processor)	X	X	X

Optional Discrete Graphics Solutions

	<u>DM</u>	<u>SFF</u>	<u>MT</u>
AMD RADEON R9 255 2GB PCIe x16			X
AMD RADEON R7 240 2GB PCIe x16		X	X
AMD Radeon HD 8350 (1GB) PCIe x16		X	X
AMD Radeon HD 8490 (1GB) PCIe x 16		X	X
NVIDIA NVS 310 (512 MB) PCIe x16		X	X
NVIDIA NVS 315 (1GB) PCIe x 16		X	X
NVIDIA GeForce GT 630 DP PCIe FHx16		X	X

Dual Graphics Support Information¹

AMD A-Series Accelerated Processor (APU) based PC with an AMD Radeon™ DirectX® 11 capable discrete graphics card. Only AMD Radeon™ Dual Graphics combines two powerful Radeon™ DirectX 11-enabled graphics processors to provide a stellar performance boost when you need it. Experience higher resolutions with greater image quality and boost visual performance when you combine a Quad-Core AMD APU for desktops with the AMD Radeon™ HD graphics card.¹

By default, dual graphics is not enabled. The customer must open the AMD Catalyst Control Center app and enable this function.

Dual Graphics Compatibility Chart

Processor	Discrete Graphics Card (optional)			
	<u>HD 8350 1GB FH PCIe x16</u>	<u>HD 8350 1GB PCIe x16 DH</u>	<u>HD 8490 1GB PCIe x16</u>	<u>R7 240 2GB FH PCIe x16</u>
A10 PRO-7850B				X
A10 PRO-7800B				X
A10-6800B	X	X	X	
A8-6500B	X	X	X	
A8 PRO-7600B				X

X denotes which processor and discrete graphics card combinations have been tested as compatible for dual graphics.

ADAPTERS AND CABLES

	<u>DM</u>	<u>SFF</u>	<u>MT</u>
DVI Cable	X	X	X
DisplayPort Cable	X	X	X
DMS-59 to Dual DisplayPort Cable			X
DMS-59 to Dual DVI Cable			X

¹ AMD Radeon™ Dual Graphics requires an AMD “A” series APU plus an AMD Radeon™ discrete graphics configuration and is available on Windows® 7 Professional, Windows 7 Ultimate, Windows® 7 Home Premium, and/or Windows® 7 Home Basic OS. Linux OS supports manual switching which requires restart of X-Server to engage and/or disengage the discrete graphics processor for dual graphics capabilities. Additional hardware (e.g. Blu-ray drive, HD or 10-bit monitor, TV tuner, wirelessly enabled HDTV) and/or software (e.g. multimedia applications) are required for the full enablement of some features. HD Video display requires an HD video source.



Standard Features and Configurable Components

DMS-59 to Dual VGA Cable			X
DisplayPort to DisplayPort Cable	X	X	X
DisplayPort to DVI-D Adapter	X	X	X
DisplayPort to HDMI Adapter	X	X	X
DisplayPort to VGA Adapter	X	X	X
Serial Port Adapter		X	X
Parallel Port Adapter		X	X

STORAGE*

Hard Disk Drives (HDD)	<u>DM</u>	<u>SFF</u>	<u>MT</u>
500 GB 7200 rpm HDD	X	X	X
500 GB 7200 rpm SED HDD	X	X	X
500 GB 10K rpm HDD		X	X
1 TB 7200 rpm HDD		X	X
1 TB 10K rpm HDD		X	X
2 TB 7200 rpm HDD		X	X

Solid State Hybrid Drives (SSHD)	<u>DM</u>	<u>SFF</u>	<u>MT</u>
500 GB SSHD (8 GB cache)	X	X	X
1 TB SSHD (8 GB cache)	X	X	X

Solid State Drives (SSD) & Self-encrypting Solid State Drives (SED)	<u>DM</u>	<u>SFF</u>	<u>MT</u>
128 GB SSD		X	X
128 GB M.2 PCIe SSD	X		
128 GB Opal 2 SED	X	X	X
256 GB Opal 2 SED	X	X	X
256 GB SED		X	X
Intel Pro 1500 120 GB Opal 1 SED	X	X	X
Intel Pro 1500 180 GB Opal 1 SED	X	X	X

*For hard drives and solid state drives, GB = 1 billion bytes. Actual formatted capacity is less. Up to 16 GB (for Windows 7) and 36 GB (for Windows 8.1) of system disk is reserved for the system recovery software.

Optical Disc Drives	<u>DM</u>	<u>SFF</u>	<u>MT</u>
Slim DVD-ROM		X	X
Slim BDXL Blu-ray Writer		X	X
Slim SuperMulti DVD Writer		X	X

Removable	<u>DM</u>	<u>SFF</u>	<u>MT</u>
HP Slim Removable SATA HDD Frame/Carrier		X	X

Media Card Reader (optional)

15-in-1 USB2/3.5 Media Card Reader			X
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Standard Features and Configurable Components

SD Carder Reader 5-in-1	X
Supports Secure Digital (SD, SDXC, SDHC, UHS-I, UHS-II)	

MEMORY*

Form Factor	Type	Maximum	# of Slots
Desktop Mini	DDR3 non-ECC Up to 1600 MT/s	16 GB	2 SODIMM
Small Form Factor	DDR3 non-ECC Up to 1600 MT/s	32 GB	4 DIMM
Microtower	DDR3 non-ECC Up to 1600 MT/s	32 GB	4 DIMM

* Full availability of 4 GB or more of memory requires a 64-bit operating system. With Windows 32-bit operating systems, the amount of usable memory is dependent upon your configuration, so that above 3 GB all memory may not be available due to system resource requirements.

Memory modules support data transfer rates up to 1600 MT/s; actual data rate is determined by the system's configured processor. See processor specifications for supported memory data rate.

NETWORKING/COMMUNICATIONS

Ethernet (RJ-45)	<u>DM</u>	<u>SFF</u>	<u>MT</u>
Broadcom NetXtreme Gigabit Ethernet Plus – DASH compliant NIC (integrated)	X	X	X
Intel Ethernet I210-T1 PCIe x1 Gb Network Interface Card (optional)		X	X

Wireless LAN (optional)*	<u>DM</u>	<u>SFF</u>	<u>MT</u>
Intel Wireless-N 7260 802.11 M.2 a/b/g/n NIC Card Wireless Network Connection	X		
Intel Wireless-N 7260 802.11 a/b/g/n PCIe- Clink Card (SFF/MT Only) Wireless Network Connection		X	X
HP Wireless 802.11 a/b/g/n 2x2 Dual Band Mini Card with Bluetooth NIC		X	X

* Wireless access point and Internet service required and not included. Availability of public wireless access points limited

AUDIO/MULTIMEDIA

	<u>DM</u>	<u>SFF</u>	<u>MT</u>
HD audio with Realtek ALC221 codec (all ports are stereo)	X	X	X
DTS Studio Sound audio management technology	X	X	X
Microphone* and headphone front ports (3.5mm)	X	X	X
Line-out and Line-In rear Ports* (3.5mm)	Line out only	X	X
Multi-streaming capable*	X	X	X
Internal speaker (standard)	X	X	X

* The front microphone port is re-taskable as a Line-in, Microphone-in or Headphone-out port. Rear audio input ports are re-taskable as a Line-in or Microphone-in port. External speakers must be powered externally. Multi-streaming can be enabled in the Realtek control panel to allow independent audio streams to be sent to/from the front and rear jacks. This allows for different audio applications to use separate audio ports on the system. For example, the front jacks could be used with a headset for a communications application while the rear jacks are being used with external speakers and a multimedia application.



Standard Features and Configurable Components

KEYBOARDS AND POINTING DEVICES

Keyboard

	<u>DM</u>	<u>SFF</u>	<u>MT</u>
HP PS/2 Keyboard	X	X	X
HP USB Keyboard	X	X	X
USB Smart Card (CCID) Keyboard	X	X	X
HP USB PS/2 Washable Keyboard**	X	X	X
HP Wireless Keyboard and Mouse Combo*, **	X	X	X

*Keyboard contains 25% post-consumer recycled plastic material.

** Low Halogen - External power supplies, power cords, cables and peripherals are not Low Halogen. Service parts obtained after purchase may not be Low Halogen.

Mice

	<u>DM</u>	<u>SFF</u>	<u>MT</u>
HP PS/2 Mouse	X	X	X
HP USB Mouse	X	X	X
HP USB 1000dpi Laser Mouse	X	X	X
HP USB PS/2 Washable Mouse**	X	X	X

HP BIOS

Key features of the HP BIOS include:

- Deployment and manageability – HP BIOS provides several technologies that help integrate the HP EliteDesk 705 G1 Business PC into the enterprise, such as PXE, remote configuration, remote control, and F10 Setup support for 12 languages.
- Stability – HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- UEFI specification 2.1
- Absolute Persistence Module – For tracking and tracing services, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management – The HP BIOS provides and enables thermal and power management technologies so component temperatures are managed for high reliability and to assist in operating the HP Business Desktop computer in any enterprise environment.
- Acoustic performance – Industry leading acoustic emissions across the range of operating conditions.
- Serviceability – HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery – HP BIOS provides numerous ways to upgrade HP Business Desktop computers, including BIOS updates from within DOS (DOSFlash), BIOS updates from within Windows (HPQFlash), HP Client Manager, and fail-safe recovery. In addition, the HP Business Desktop BIOS Utilities tool enables replicated BIOS setup throughout the Enterprise; it is available from within the BIOS software and from the support website.
- HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery.

Additional HP BIOS Features

- Power-On password – Helps prevent an unauthorized user from powering on the system.
- Administrator password – Also known as the setup password, this helps prevent unauthorized changes to the system configuration. If the administrator password is not known, the BIOS version cannot be changed and changes cannot be made to BIOS settings using F10 setup or under the OS.
- Advanced Configuration and Power Interface (ACPI) – Represents a significant innovation in power and configuration management, allowing operating systems and applications to manage power based on activity and usage. HP Elite



Standard Features and Configurable Components

models use ACPI to provide power conservation features.

S5 Max Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 1W in S5 (when turned off). When S5 Max Power Savings feature is enabled power to slots is turned off along with WOL functionality.

SECURITY

	DM	SFF/MT
Trusted Platform Module (TPM) 1.2	X	X
SATA port disablement (via BIOS)	X	X
Drive lock	X	X
RAID configurations		X
Serial, parallel, USB enable/disable (via BIOS)	X	X
Optional USB Port Disable at factory (user configurable via BIOS)	X	X
Removable media write/boot control	X	X
Power-On password (via BIOS)	X	X
Setup password (via BIOS)	X	X
Solenoid Hood Lock / Sensor		X
Support for chassis padlocks and cable lock devices	X	X

ENVIRONMENTAL & REGULATORY

ENERGY STAR® qualified models available

EPEAT® registered where applicable/supported. See www.epeat.net for registration status by country.

Low halogen (chassis, all internal components and modules)*

TAA compliant

* External power supplies, power cords, cables and peripherals are not Low Halogen. Service parts obtained after purchase may not be Low Halogen.

PORTS

I/O Ports – Standard

	DM	SFF/MT
USB 2.0	2 (rear)	2 (front); 4 (rear)
USB 3.0	2 (front); 2 (rear)	2 (front); 2 (rear)
Serial (RS-232)	N/A	1
PS/2	N/A	1 keyboard (purple) 1 mouse (green)
Video	1 ea. VGA 2 ea. DisplayPort	1 ea. VGA 2 ea. DisplayPort
Audio	Front: headphone/mic Rear: line in/out 3.5mm diameter	Front: headphone/mic Rear: line in/out 3.5mm diameter
Network Interface	RJ-45	RJ-45

I/O Ports – Optional

	DM	SFF/MT
2nd Serial (RS-232)	N/A	1



Standard Features and Configurable Components

Parallel	N/A		1
SLOTS			
	<u>DM</u>	<u>SFF</u>	<u>MT</u>
M.2	1 ea. M.2-2230 (for WLAN) 1 ea. M.2-2280 (for storage)	N/A	N/A
PCI Express x1 (v2.0)	N/A	2 ea. 2.5" low profile 6.6" length 10W max. power	2 ea. 4.376" full height 6.6" length 10W max. power
PCI Express x16 (v2.0) (wired as a x4)	N/A	1 ea. 2.5" low profile 6.6" length 10W max. power	1 ea. 4.376" full height 6.6" length 10W max. power
PCI Express x16 (v3.0)	N/A	1 ea. 2.5" low profile 6.6" length 75W max. power	1 ea. 4.376" full height 6.6" length 75W max. power

BAYS

	<u>DM</u>	<u>SFF</u>	<u>MT</u>
5.25" Half Height ODD	N/A	N/A	N/A
Slim ODD	N/A	1 ea.	1 ea.
Secure Digital (SD) Reader	N/A	N/A	1 ea.
2.5" internal storage drive	1 ea.	1 ea.	N/A
3.5" internal storage drive	N/A	2 ea.	2 ea.

SERVICE AND SUPPORT

On-site Limited Warranty 1: Three-year (3-3-3) limited warranty delivers three years of on-site, next business day 2 service for parts and labor and includes free telephone support 3 24 x 7. Three-year onsite and labor are not available in all countries. Service offers terms up to 5 years by choosing a Care Pack. To choose the right level of service for your HP product, visit HP Care Pack Central: www.hp.com/go/cpc

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.

NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

NOTE 3: Technical telephone support applies only to HP-configured and third-party HP qualified hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries.

SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

Included	Windows 7	Windows 8.1
Security	Absolute Persistence Module ¹⁰ HP Device Access Manager with Just In Time	Absolute Persistence Module ¹⁰ HP Device Access Manager with Just In Time



Standard Features and Configurable Components

	Authentication	Authentication
	HP Drive Encryption ³	HP Drive Encryption ³
	HP File Sanitizer (SSDs and Hybrid Drives not supported) ⁴	HP File Sanitizer (SSDs and Hybrid Drives not supported) ⁴
	HP Disk Sanitizer External Edition ^{1, 5}	HP Disk Sanitizer External Edition ^{1, 5}
	HP Client Security	HP Client Security
	HP SpareKey	HP SpareKey
	Microsoft Security Essentials ⁶	Microsoft Defender
MultiMedia	Cyberlink Power DVD, BD	Cyberlink Power DVD, BD
	Cyberlink Power2Go (Secure Burn)	Cyberlink Power2Go (Secure Burn)
	CyberLink YouCam BE ⁷	
Communication		HP Wireless Hotspot
HP Value Add	HP ePrint Driver ²	HP ePrint Driver ²
	HP PageLift ⁸	HP PageLift ⁸
	HP Manageability (Activation Required)	HP Manageability (Activation Required)
	HP Recovery Manager	HP Recovery Manager
	HP Support Assistant	HP Support Assistant
	HP Recovery Disk Creator	
3rd Party	Box 50 GB Offer ⁹	Box Application
	Foxit PhantomPDF Express	Foxit PhantomPDF Express
	Skype	Skype
Microsoft Products	Buy Office	Buy Office

¹ Available via download

² Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see www.hp.com/go/eprintcenter). Requires optional broadband module. Broadband use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Separately purchased data plans or usage fees may apply. Print times and connection speeds may vary

³ Drive Encryption requires Windows. Data is protected prior to Drive Encryption login. Turning the PC off or into hibernate logs out of Drive Encryption and prevents data access.

⁴ For the use cases outlined in the DOD 5220.22-M Supplement. Does not support Solid State Drives (SSDs). Initial setup required. Web history deleted only in Internet Explorer and Firefox browsers and must be user enabled. With Windows 8.1, user must turn off Enhanced Protection Mode in IE11 for shred on browser close feature.

⁵ For the use cases outlined in the DOD 5220.22-M Supplement. Does not support Solid State Drives (SSDs). Requires Disk Sanitizer, External Edition for Business Desktops from hp.com.

⁶ Requires Windows 7 and internet access.

⁷ Preinstalled on models with webcam.

⁸ Requires Windows 7 or higher.

⁹ Requires Box registration. Offer available to new Box users only. Box App requires Windows 8 or 8.1. Offer subject to change without notice.

¹⁰ BIOS Absolute Persistence module is shipped turned off, and will be activated when customers purchase and activate a subscription. Service may be limited. Check with Absolute for availability outside the U.S. The optional subscription service of Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit:

<http://www.absolute.com/company/legal/agreements/computrace-agreement>. If Data Delete is utilized, the Recovery Guarantee payment is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either create a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

AMD® DASH TECHNOLOGY CAPABLE

The DASH standards are designed to assist in the remote management of common desktop infrastructure tasks, such as deploying new operating systems, monitoring of computer system health, power control and power state monitoring, and asset inventory collection. As new hardware technologies are introduced or additional requirements are placed on the IT



Standard Features and Configurable Components

infrastructure, DASH will continue to evolve to include new functionality.

DASH has been designed to solve many of the pitfalls and constraints of previous management standards by leveraging well-proven technologies from the Service Oriented Architecture domain, advancements in security standards, and extensive modeling of management components, configuration data and relationships first introduced in the server management domain.

DASH is a web services-based management protocol and relies on security and network routing concepts familiar to web site and web services administrators.

Key Features

- Service availability without the requirement of an installed operating system and/or system power states
- Interoperability between various DASH-capable device implementations and management consoles
- Descriptive data model allowing for the discovery of iterative specification updates (new profiles) or vendor-specific extensions (custom profiles)
- Well understood transport level security (HTTPS basic and digest authentication models with optional TLS client/server certificate support)
- Secured setup with support for multiple DASH users and multiple access roles (administrator, operator, auditor)
- DASH ecosystem can coexist with legacy Alert Standard Format (ASF) infrastructure
- Control boot sources, redirect boot to a redirected USB sessions
- Forward POST logs to specified destination
- Monitor and inventory the HW of the managed clients

Management Profiles

A management profile is a specification that defines a normative set of behaviors and characteristics for addressing a particular management domain.

A profile consists of the following information:

- A data model representing the problem domain that consists of objects, properties and methods exposed by the profile
- Use cases to be addressed by the profile
- Steps required to traverse the data model and derive results

When a substantive block of new profiles become available, or fundamental changes are introduced to the DASH ecosystem, the DASH Implementation Requirements document is updated to reflect a new version of the standard. Profiles are continually being developed by the DMTF and DASH is designed to support them as they become available.

AMD® STANDARD MANAGEABILITY

Includes DASH 1.0/1.1 compliance plus:

- System Defense
- Agent Presence
- SOL/IDE Redirection
- CISCO NAC/SDN support
- ME Wake on LAN
- Host Based Configuration
- ME Firmware Rollback
- IPv6 Support

DASH 1.0/1.1 compliance:

- Boot Control



Standard Features and Configurable Components

- HW Inventory
- SW Inventory
- Power State Management
- HW Alerting

Feature	DMTF Specification(s)
Alert Standard Format (ASF 2.0)	DSP0136
DASH Implementation Requirements	DSP0232
System inventory and control	DSP1058, DSP1033, DSP1029, DSP1027, DSP1026, DSP1023, DSP1022, DSP1015, DSP1013, DSP1012, DSP1011
Boot control	DSP1012
User account management	DSP1034, DSP1039
BIOS management	DSP1061
Offline mailboxes/Opaque management data	DSP1070
Indications	DSP1054
In-band NIC management	DSP1014
Sensors	DSP1009
Text console redirection (+Telnet and SSHv2)	DSP1024
Broadcom defined SMBIOS Extensions for Sensors	DSP0134
MCTP / SMBus	DSP0236, DSP0237, DSP0239
PLDM	DSP0240, DSP0241, DSP0245
PLDM for SMBIOS Data Transfer	DSP0246
PLDM for BIOS Control and Configuration	DSP0247
PLDM Numeric Sensors	DSP0248
WMI provider for Ethernet port & SW inventory	DSP1014, DSP1023
WMI provider for User account Mgmt	DSP1034, DSP1039
WMI provider for firmware update	DSP1025
USB redirection (storage media; read only)	DSP1077
Power State management or Power Control (including graceful shutdown)	DSP1027
Event logging	DSP1010, DSP8007
Record log audit or security log	DSP1010
WMI provider for Opaque Mgmt data	DSP1070
PLDM Platform Event Messages	DSP0248
Service Processor	DSP1018
Physical Computer System View	in progress



Technical Specifications – Graphics

Integrated AMD HD Graphics		
VGA Controller	Integrated	
DisplayPort	<ul style="list-style-type: none"> • DP++ • DisplayPort audio: <ul style="list-style-type: none"> ○ Linear PCM, Dolby Digital (AC-3), Dolby TrueHD, DTS, and DTS-HD Master Audio ○ LPCM at sample rates: 32 kHz, 44.1 kHz, 48 kHz, 88.2 kHz, 96 kHz, 176.4 kHz, and 192 kHz, Bits per sample: 16, 20, and 24 ○ Supports up to 8 channels • 4, 2, or 1-lane transmission • 5.4 Gbps (HBR2), 2.7 Gbps, and 1.62 Gbps link bit rates • DisplayPort Multi-Stream Transport (MST) for up to four independent video and audio streams on one connector • Maximum resolution of 4096 x 2160 at 30 Hz and 24 bpp (single stream) <ul style="list-style-type: none"> ○ Supports 2560 x 1600 at 60 Hz (single stream) ○ Support for tiled displays with resolution of up to 4096 x 2160 at 60 Hz DisplayPort 1.2 MST <p>Supports stereoscopic 3D gaming, Blu-ray 3D, and stereoscopic 3D video for 120-Hz frame sequential monitors</p>	
Memory	Allocated at system startup and configurable using F10 setup with values of 128MB, 256MB, 512MB and 1024MB. Additional memory that is not in use by the host will be dynamically allocated and will vary depending on the total installed system memory.	
Maximum Graphics Memory	Microsoft Windows 7	Windows 8.1
	Variable*	Variable*
	* Actual amount of maximum graphics memory can vary depending on the amount of installed system memory	
Maximum Color Depth	32 bits/pixel, 8-bits per color component	
Graphics/Video API Support	<ul style="list-style-type: none"> • Discrete-level graphics processor embedded alongside the x86 CPU complex • Dedicated graphics memory controller <p>AMD Eyefinity AMD Eyefinity support for up to four displays when at least two displays are operating with DisplayPort 1.2 multi-streaming.</p> <p>AMD Dual Graphics support Available with select combinations of A8 and A10 processors with select AMD graphics cards</p> <ul style="list-style-type: none"> • AMD Asynchronous CrossFire™ Technology <p>Power Management</p> <ul style="list-style-type: none"> • AMD PowerPlay™ power management technology <ul style="list-style-type: none"> ○ Dynamic power gating for GPU, UVD, VCE, GFX, DCE, and Graphics Memory Controller (GMC) • Dynamic refresh rate supported with digital panels that support this feature • Dynamic refresh rate • Frame Buffer Compression • Panel Self-Refresh 	



Technical Specifications – Graphics

3D Acceleration Features

DirectX® 11.1 compliant, including full speed 32-bit floating point per component operations:

Shader Model 5 geometry and pixel support in a unified shader architecture

- Graphics Core Next (GCN) architecture
- Advanced shader instructions, including flexible flow control with CPU-level flexibility on branching
- Read/Write caching system, replacing texture cache with a unified read-write two-level cache
- Vertex, pixel, geometry, compute, domain, and hull shaders
- 32-bit and 64-bit floating point processing per component
- High performance dynamic branching and flow control
- Shader instruction store, using an advanced caching system
- Advanced shader design, with ultra-threading sequencer for high efficiency operations
- Advanced, high performance branching support, including static and dynamic branching
- High dynamic range rendering with floating point blending, texture filtering, and anti-aliasing support
- 16-bit and 32-bit floating point components for high dynamic range computations
- Full anti-aliasing on render surfaces up to and including 128-bit floating point formats
- Support for OpenCL™ 1.2, DirectCompute 11 and Microsoft C++ AMP
- Support for OpenGL 4.1/4.1+

Motion Video Acceleration Features

- Supports DVD, Blu-ray, and SDTV/HDTV content playback with low CPU usage
- Supports stereoscopic 3D Blu-ray
- Video compression engine:
 - Dedicated hardware (VCE 2.0) assisted encoding of HD video streams to H.264 (main profile)
 - Support H.264 SVC temporal scalability
 - Real-time transcoding by encoding the output from UVD with reduction of CPU utilization and power consumption
- Motion video decode acceleration technology:
 - Dedicated hardware (UVD) for H.264, MPEG4, VC-1, MVC, and MPEG2 decode:
 - H.264 implementation based on the ISO/IEC 14496-10 specification
 - MPEG6 implementation based on the ISO/IEC 14496-2 specification
 - VC-1 implementation based on the SMPTE 421M specification
 - MPEG2 implementation based on the ISO 13818-2 specification
 - Multi View Coding (MVC) for Blu-ray 3D content
 - WMV-9 implementation
 - Real time high-definition and standard definition stream decode
 - Real time dual high-definition stream decode

AMD Radeon R9 255 2GB PCIe x16

Memory

2GB 128-bit wide frame buffer operating at 1150MHz.



Technical Specifications – Graphics

Controller Clock Speed	AMD Cape Verde GPU engine operating at 900 MHz.
Multidisplay Support	Yes (2)
Graphics /API support	Supports Microsoft DirectX 11.1, OpenGL 4.3 and OpenCL 1.2 APIs. DX 11.1, Shader Model 5, UVD 4.2, VCE 2.0, OpenGL 4.2 (4.1+), OpenCL 1.2, and DirectCompute 11
Output Connectors	1 x of each Dual-Link DVI-I, DisplayPort 1.2 and HDMI 1.4 output connectors. DisplayPort and HDMI outputs support audio 1 VGA and 1 DisplayPort1.2

Supported Display Resolutions and Refresh Rates

Note: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

SUPPORTED DVI-D (DIGITAL) AND DISPLAYPORT DISPLAY MODES Resolution	Depth (BPP)	Refresh Rate (Hz)
320x200	8, 16, 32	60
320x240	8, 16, 32	60
400x300	8, 16, 32	60
480x360	8, 16, 32	60
512x384	8, 16, 32	60
640x350	8, 16, 32	60
640x400	8, 16, 32	60
640x480	8, 16, 32	60
720x480	8, 16, 32	60
720x576	8, 16, 32	60
800x600	8, 16, 32	60
1024x768	8, 16, 32	60
1152x864	8, 16, 32	60
1280x720	8, 16, 32	60
0.98M9 (1280x768)	8, 16, 32	60
1280x960	8, 16, 32	60
1280x1024	8, 16, 32	60
1.30MA (1440x900)	8, 16, 32	60, 75
1600x900	8, 16, 32	60
1.64MA (1600x1024)	8, 16, 32	60
1600x1200	8, 16, 32	60
1.76MA (1680x1050)	8, 16, 32	60
1.76MA-R (1680x1050)	8, 16, 32	75-R
2.07M9-R (1920x1080)	8, 16, 32	60-R
2.30MA-R (1920x1200)	8, 16, 32	60-R
2560x1440	8, 16, 32	60
2560x1600	8, 16, 32	60

VGA AND DVI-A (ANALOG) DISPLAY MODES

Resolution	Depth (bpp)	CRT Refresh Rate (Hz)
320x200	8, 16, 32	60, 75, 85
320x240	8, 16, 32	60, 75, 85
400x300	8, 16, 32	60, 75, 85
480x360	8, 16, 32	60, 75, 85
512x384	8, 16, 32	60, 75, 85
640x350	8, 16, 32	60, 75, 85



Technical Specifications – Graphics

640x400	8, 16, 32	60, 75, 85
640x480	8, 16, 32	60, 75, 85
720x480	8, 16, 32	60, 75, 85
720x576	8, 16, 32	50, 60, 75, 85
800x600	8, 16, 32	60, 75, 85
1024x768	8, 16, 32	60, 75, 85
1152x864	8, 16, 32	60, 75, 85
1280x720	8, 16, 32	60, 75, 85
0.98M9 (1280x768)	8, 16, 32	60, 75, 85
1280x960	8, 16, 32	60, 75, 85
1280x1024	8, 16, 32	60, 75, 85
1.30MA (1440x900)	8, 16, 32	60, 75
1600x900	8, 16, 32	60, 75, 85
1.64MA (1600x1024)	8, 16, 32	60, 75, 85
1600x1200	8, 16, 32	60, 75, 85
1.76MA (1680x1050)	8, 16, 32	60, 75
1920x1080	8, 16, 32	60, 75, 85
2.30MA (1920x1200)	8, 16, 32	60, 75, 85
1920x1440	8, 16, 32	60, 75, 85
2048x1536	8, 16, 32	60, 75

AMD Radeon R7 240 2GB PCIe x16

Memory	2048MB DDR3 128-bit wide frame buffer running at 1800MHz.
Controller Clock Speed	AMD R14D-M2-70 GPU engine running at 730 MHz.
Multidisplay Support	Yes (2)
Graphics /API support	Supports Microsoft DirectX 11.1, OpenGL 4.3 and OpenCL 1.2 APIs. DX 11.1, Shader Model 5, UVD 4.2, VCE 2.0, OpenGL 4.2 (4.1+), OpenCL 1.2, and DirectCompute 11
Output Connectors	1 x of each DVI-I (VGA via dongle output), and HDMI connectors.

Supported Display Resolutions and Refresh Rates

Note: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	VGA	DVI-D	HDMI
640x480	85	60	60
720x480	85	60	60
720x576	85	60	60
800x600	85	60	60
1024x768	85	60	60
1280x720	85	60	60
1280x768	85	60	60
1280x1024	85	60	60
1440x900	85	60	60
1600x1024	85	60	60
1600x1200	85	60	60
1680x1050	75	60	60
1920x1080	85	60*	60
1920x1200	85	60*	NA
1920x1440	85	NA	NA



Technical Specifications – Graphics

2048x1536	75	NA	NA
2560x1440	NA	NA	NA
2560x1600	NA	NA	NA
* Requires display with support for reduced blanking timing			

NVIDIA NVS 310 Graphics Card

Introduction	<p>The NVIDIA® NVS™ 310 Graphics Card is a PCI Express low profile form factor graphics add-in card targeted as an active low cost graphics solution for the corporate business and enterprise markets.</p> <p>The NVIDIA® NVS 310 graphics card is an ideal solution for customers requiring a small form factor graphics add-in card for either standard or small form factor PC designs.</p>		
Performance and Features	<p>The NVIDIA® NVS 310 Graphics Card offers 512 MB of ultrafast DDR3 memory and is capable of supporting up to 2 displays.</p> <p>DisplayPort connector supports multimode technology to support connection to DVI-D, VGA and HDMI monitors with optional adapters in kits NR078AA, FH973AT, BP937AA, AS615AA.</p> <p>For a DisplayPort to DisplayPort connections use the optional DisplayPort Cable Kit VN567AA.</p>		
Form Factor	Low Profile: 2.713 × 6.15 in		
Graphics Controller	NVIDIA® NVS 310		
Memory Clock	875MHz		
Memory Size	512 MB DDR3		
Memory Bandwidth	14 GB/s		
Max. Power	19.5W		
Display Max. Resolution	Up to 2560 × 1600 (digital display) per display		
Display Output	Up to 2 displays in the following configurations		
	DisplayPort output:	<ul style="list-style-type: none"> • Drives two DisplayPort enabled digital display at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking, when connected natively using the 2 DisplayPort connectors on the NVS 310 graphics card • Supports 2 monitors up to resolution of 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort Multi-Stream topology technology. 	
	DVI-D output:	<ul style="list-style-type: none"> • Drives two digital display at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors • Drives two digital display at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors 	



Technical Specifications – Graphics

HDMI output:	<ul style="list-style-type: none"> NVS 310 is capable of driving two high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors
VGA display output:	<ul style="list-style-type: none"> Drives two analog display at resolutions up to 1920 × 1200 at 60 Hz using DisplayPort to VGA cable adaptors

Supported Display Resolutions and Refresh Rates

Note: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Maximum Refresh Rates (Hz) by Connection			
	DisplayPort to VGA	DisplayPort to DVI-D	DisplayPort to HDMI	DisplayPort
640 x 480	85	60	60	60
800 x 600	85	60	60	60
1024 x 768	85	60	60	60
1280 x 720	85	60	60	60
1280 x 1024	85	60	60	60
1440 x 900	75	60	60	60
1600 x 1200	60	60	60	60
1680 x 1050	60	60	60	60
1920 x 1080	60-R	60-R	60	60
1920 x 1200	60-R	60-R		60
1920 x 1440				60
2048 x 1536				60
2560 x 1600				60

NVIDIA NVS 315 1GB PCIe x 16 Graphics Card

Introduction	Get efficient dual-display graphics performance in a PCI Express low-profile graphics card with the NVIDIA NVS 315 PCIe x16 1 GB Graphics Card, an ideal desktop graphics solution for professional business and commercial applications.
Performance and Features	<p>The NVIDIA® NVS 315 Graphics Card offers 1 GB of ultrafast DDR3 memory and is capable of supporting up to 2 displays.</p> <p>DisplayPort connector supports multimode technology to support connection to DVI-D, VGA and HDMI monitors with optional adapters in kits NR078AA, FH973AT, BP937AA, AS615AA.</p> <p>For a DisplayPort to DisplayPort connections use the optional DisplayPort Cable Kit VN567AA.</p>
Form Factor	Low Profile: 2.713 × 6.15 in
Graphics Controller	NVIDIA® NVS 315
Memory Clock	875MHz
Memory Size	512 MB DDR3



Technical Specifications – Graphics

Memory Bandwidth	14 GB/s
Connectors	DMS-59 , with support for dual VGA, dual DVI or dual Display Port with the appropriate adapter cable
Display Max. Resolution	Up to 2048 x 1536 VGA; 1920 x 1200 DVI; 2560 x 1600 DisplayPort
Display Output	Up to 2 displays in the following configurations
	<ul style="list-style-type: none"> • Dual DVI : <ul style="list-style-type: none"> ○ Drives two DVI displays using optional HP DMS59 DVI Dual-head Connector Cable DL139A • Dual DisplayPort : <ul style="list-style-type: none"> ○ Drives two DisplayPort using optional HP DMS-59 to Dual DisplayPort kit XP688AA • Dual VGA : <ul style="list-style-type: none"> ○ Drives two analog using the included HP DMS-59 to Dual VGA Cable

Supported Display Resolutions and Refresh Rates

Note: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Maximum Refresh Rates (Hz) by Connection	
	Analog Connection	Digital Connection
640 x 480	85	60
720 x 480	85	60
720 x 576	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 768	85	60
1280 x 1024	85	60
1440 x 900	75	60
1600 x 1024	85	60
1600 x 1200	85	60
1680 x 1050	75	60
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	N/A
2048 x 1536	75	N/A
2560 x 1440	N/A	60*
2560 x 1600	N/A	60*
		* Display Port Only

AMD Radeon HD 8350 1GB PCIe x16 DH Graphics Card



Technical Specifications – Graphics

Introduction	Get stable 2D and advanced 3D graphics performance from the AMD Radeon HD 8350 1 GB PCIe x16 DH Graphics Card, a low profile, PCI Express x16 graphics add-in card based on the AMD Radeon HD 8350 GPU, great for Web conferencing or video and photo editing.
Form Factor	PCIe x16
Graphics Controller	AMD Radeon HD 8350
Core Clock	GPU engine operates at 523 MHz
Memory	1GB, DDR3, SDRAM
Memory Clock	875 MHz
HDCP Support	Yes
Display Max. Resolution	Digital 1920 x 1200 Analog 2048 x 1536

Supported Display Resolutions and Refresh Rates

Note: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

	Analog Connection	Digital Connection
640 x 480	85	60
720 x 480	85	60
720 x 576	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 768	85	60
1280 x 1024	85	60
1440 x 900	75	75
1600 x 1024	85	60
1600 x 1200	85	60
1680 x 1050	75	75-R
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	N/A
2048 x 1536	75	N/A
2560 x 1440	N/A	N/A
2560 x 1600	N/A	N/A

AMD Radeon HD 8490 1GB PCIe x16 Graphics Card



Technical Specifications – Graphics

Introduction	Get impressive graphics and high resolution dual-display performance in a low profile, PCI Express x16 graphics add-in card based on the AMD Radeon HD 8490 Graphics Processor. Improve your everyday PC, Web conferencing, and video or photo editing.
Form Factor	PCIe x16
Graphics Controller	AMD Radeon HD 8490
Core Clock	GPU engine operates at 875 MHz
Memory	1GB, DDR3, SDRAM
Memory Clock	900 MHz
HDCP Support	Yes
Display Max. Resolution	Digital 2560 x 1600, Analog 2048 x 1536

Supported Display Resolutions and Refresh Rates

Note: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

	Analog Connection	Digital Connection
300 x 200	85	60
320 x 240	85	60
400 x 300	85	60
640 x 480	85	60
720 x 480	85	60
720 x 576	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 768	85	60
1280 x 1024	85	60
1440 x 900	75	75
1600 x 900	85	60
1600 x 1024	85	60
1600 x 1200	85	60
1680 x 1050	75	75-R
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	N/A
2048 x 1536	75	N/A
2560 x 1440	N/A	60
2560 x 1600	N/A	60



Technical Specifications – Graphics

NVIDIA GeForce GT630 Graphics Card

Introduction	<p>The NVIDIA GeForce GT630 DP (2GB) PCIe x16 Card Graphics Card provides a full height, PCI Express x16 graphics add-in card solution based on the NVIDIA Kepler Architecture GPU. The card is designed to support three display connections through its DVII, and two DisplayPort connectors.</p> <p>An ideal solution for desktop PC customers seeking enhanced 2D and advanced 3D graphics performance, the NVIDIA GeForce GT630 DP (2GB) PCIe x16 Cards are an excellent choice for business users who want run multiple displays from a single graphics board. Engage in Web conferencing or video or photo editing, while improving your everyday business PC experience with better graphics and excellent visual display quality.</p>
Performance and Features	<p>The NVIDIA GeForce GT630 DP (2GB) PCIe x16 Cards deliver superior PCI Express (PCIe) Gen 3 features including:</p> <ul style="list-style-type: none"> • Unprecedented flexibility for new applications and enhanced performance • Support for NVIDIA surround technology • Run multiple displays from a single graphics card • Full 16 lane PCIe Generation 3 bus support with peak bandwidth support • Wireless Display ready for future support
Form Factor	PCIe x16 Card
Graphics Controller	NVIDIA Kepler Architecture GPU
Core Clock	875 MHz
Memory Clock	891 MHz
Memory Size	2 GB DDR3 128 bit
Memory Bandwidth	28.5 GB/s
Display Max. Resolution	2560 x 1600 digital, 2048 x 1536 analog
Display Support	Integrated 400 MHz RAMDAC

Supported Display Resolutions and Refresh Rates

Note: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Maximum Refresh Rates (Hz)	
	Analog Connection	Digital Connection
640 x 480	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 1024	85	60
1440 x 900	75	60
1600 x 1200	85	60



Technical Specifications – Graphics

1680 x 1050	75	60
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	60
2048 x 1536	75	60
2560 x 1600	N/A	60



Technical Specifications – Hard Disk and Solid State Storage

Introduction:

HP Serial Advanced Technology Attachment (SATA) Hard Drives maximize the performance of HP Business PCs by providing the technologies to meet your increasing storage demands with high-capacity drives offering superior reliability and performance.

SATA provides faster data transfer speeds, better system cooling airflow, more bandwidth, more headroom for speed increases in future generations and better data integrity. A next-generation technology, the SATA interface connects hard drives to the PC platform enabling easy aggregation of multiple hard drives into a single PC. This offers you the additional benefits of dedicated bandwidth, the ability to more easily identify device failures and scalability. The HP EliteDesk 705 G1 Series Business PC supports the latest SATA 6.0Gb/s specification.

HP Drive Lock

HP Serial ATA Hard Drives offer enhanced security via a new Drive Lock. When enabled, this ATA security feature set prevents software access to user data on the drive until one or two user-defined passwords are provided.

SMART IV Technology

Self-Monitoring Analysis and Reporting Technology (SMART) hard drive technology allows hard drives to monitor their own health and to raise flags if imminent failures are predicted. If the drive determines that a failure is imminent, the SMART hard drive technology enables the intelligent manageability or management software to generate a fault alert. While the current versions of SMART hard drives do a good job monitoring the data on the hard drive media, the ever increasing emphasis on reliability and quality has promoted HP to implement SMART IV technology which constantly checks that the data flow from host interface to media and media to host interface is not compromised. This is accomplished by inserting a 2 byte parity code into every 512 byte block in the data path of the hard drive's Cache RAM. This unique parity checking performed by HP's SMART IV technology hard drives, allows for more complete error detection coverage encompassing the entire data path between the host and the hard drive.

Smart IV is also known as IOEDC: I/O Error Detection Code.

Native Command Queuing

NCQ or Native Command Queuing is a SATA protocol extension that allows the hard drive to have several write or read commands outstanding at the same time. In contrast, normal non-queued operation requires each command to be completed before the next command is issued by the host system. Queuing allows the drive to complete the commands in the order that allows for best overall throughput. It also involves an advanced method of transferring data to or from the host, called First Party Direct Memory Access (FPDMA), which allows the hard drive and the host controller to manage the data transfers for multiple outstanding commands, without involving the host processor. NCQ can contribute to better performance but the results are dependent on many factors, including the access patterns of the various applications and operating system functions that are initiating drive accesses. Enabling NCQ features in the hard drive requires AHCI support from the host system BIOS, controller, and driver. AHCI support is typically implemented in RAID configurations.

***NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 16 GB (for Windows 7) and 36 GB (for Windows 8.1) of system disk is reserved for the system recovery software. GB = 1 billion bytes. Actual available capacity is less.

Redundant Array of Independent Drives (RAID)

Flexible implementation:

- DriveLock is supported while in RAID mode. Users can manage the DriveLock password from within F10 Setup. Locked drives will be displayed as such in the RAID option ROM interface.
- Hard drive information can be viewed within F10 Setup while in RAID mode. Previously, the hard drives will not appear in Drive Configuration when switching to RAID mode.



Technical Specifications – Hard Disk and Solid State Storage

- DPS Self-Test can be executed on physical hard drives while in RAID mode.
- The RAID Setup Utility (accessed through CTRL-I) can be protected by the F10 Setup password.

NOTE:

RAID 1 is the only RAID configuration offered via factory configurations. The pre-configured systems:

- Are only available on the SFF and TWR form factors. The DM form factors do not support RAID as they do not allow for multiple common storage drives.
- Are complete RAID systems and have both drives installed. If the TWR is configured with three hard disk drives, the third drive is would be un-partitioned and not part of the RAID array
- Have the necessary Option ROM configuration.
-
- Include a preinstalled operating system that is mirrored mode out of the box.

HP 1TB* 10K rpm SATA 6.0Gb/s 3.5” Hard Disk Drive		
Unformatted Capacity	1 TB	
Rotational Speed	10,000 rpm	
Interface	Serial ATA (6.0 Gb/s)	
Synchronous Transfer Rate (Maximum)	Up to 600 MB/s	
Buffer Size	64 MB	
Cache	Adaptive	
Seek Time (typical reads, includes controller overhead, including settling)	Single Track:	1.2 ms
	Average:	3.6 ms
	Full-Stroke:	9.0 ms
Height (nominal)	0.6 in/1.53 mm	
Width (nominal)	Media diameter: 2.5 in/63.6 mm	
	Physical size: 2.75 in/69.9 mm	
Operating Temperature	41° to 131° F (5° to 55° C)	

HP 500 GB* 10K rpm SATA 6.0Gb/s 3.5” Hard Disk Drive	
Unformatted Capacity	500 GB



Technical Specifications – Hard Disk and Solid State Storage

Rotational Speed	10,000 rpm	
Interface	Serial ATA (6.0 Gb/s)	
Synchronous Transfer Rate (Maximum)	Up to 600 MB/s	
Buffer Size	64 MB	
Cache	Adaptive	
Seek Time (typical reads, includes controller overhead, including settling)	Single Track:	1.2 ms
	Average:	3.6 ms
	Full-Stroke:	9.0 ms
Height (nominal)	0.6 in/1.53 mm	
Width (nominal)	Media diameter: 2.5 in/63.6 mm	
	Physical size: 2.75 in/69.9 mm	
Operating Temperature	41° to 131° F (5° to 55° C)	

HP 320 GB* 7.2K SATA 6.0Gb/s 2.5” Hard Disk Drive		
Capacity	320,072,933,376 bytes	
Rotational Speed	7,200 rpm	
Interface	Serial ATA 2.0 (6.0 Gb/s)	
Buffer Size	16 MB	
Logical Blocks	488,397,168	
Seek Time (typical reads, includes controller overhead, including settling)	Single Track:	2.0 ms
	Average:	12 ms
	Full-Stroke:	22 ms
Height (nominal)	0.374 in/9.5 mm	
Width (nominal)	Media diameter: 2.5 in/63.5 mm	
	Physical size: 2.75 in/70 mm	
Operating Temperature	41° to 131° F (5° to 55° C)	



Technical Specifications – Hard Disk and Solid State Storage

HP 500 GB* 7200 RPM SATA 2.5” Self-Encrypting (SED) Hard Disk Drive		
Capacity	500,107,862,016 bytes	
Rotational Speed	7,200 rpm	
Drive Type	Self-Encrypting Drive (SED) with SATA interface	
Interface	SATA Interface conforming to Serial ATA International Organization: Serial ATA Revision 2.6	
Segmented Buffer with write cache	32768 KB - A portion of buffer capacity used for firmware	
Number of Sectors	976,773,168	
Seek Time (typical reads)	Single Track:	1.0 ms
	Average:	13 ms
	Full-Stroke:	25 ms
Media Diameter	2.5 in/63.5 mm	
Height	0.267 in/6.8 mm, ±0.2mm	
Width	2.75 in/69.85 mm, ±0.25mm	
Length	3.945 in/100.2 mm, ±0.25mm	
Weight	3.35 oz/95 g (max)	
Operating Temperature	32° to 140° F (0° to 60° C)	

HP 500 GB* 7.2K SATA 6.0Gb/s 2.5” Hard Disk Drive		
Capacity	500,107,862,016 bytes	
Rotational Speed	7,200 rpm	
Interface	Serial ATA 2.0 (6.0 Gb/s)	
Buffer Size	16 MB	
Logical Blocks	976,773,168	
Seek Time (typical reads, includes controller overhead, including settling)	Single Track:	2.0 ms
	Average:	12 ms



Technical Specifications – Hard Disk and Solid State Storage

	Full-Stroke:	25 ms
Height (nominal)	0.374 in/9.5 mm	
Width (nominal)	Media diameter: 2.5 in/63.5 mm	
	Physical size: 2.75 in/70 mm	
Operating Temperature	41° to 131° F (5° to 55° C)	

HP 1 TB* SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)

Formatted Capacity	1 TB	
Spindle Speed	5,400 rpm +/- 0.2%	
Drive Type	Solid State Hybrid Drive (SSHD) technology with NAND Flash	
Interface	Serial ATA (SATA)	
Cache Buffer	64 MB	
NAND Flash Commercial Multilevel Cell (cMLC)	8 GB	
Number of Sectors	976,773,168	
Seek Time (typical reads)	Single Track:	2.0 ms
	Average:	12 ms
Height	0.374 +/- .008 in (9.5 +/- 0.2 mm)	
Width	2.750 +/- 0.010 in (69.85 +/- 0.25 mm)	
Length	3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)	
Weight	0.254 lb/115 g (max)	
Operating Temperature	32° to 140° F (0° to 60° C)	

HP 500 GB* SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)

Formatted Capacity	500 GB	
Spindle Speed	5,400 rpm +/- 0.2%	



Technical Specifications – Hard Disk and Solid State Storage

Drive Type	Solid State Hybrid Drive (SSHD) technology with NAND Flash	
Interface	Serial ATA (SATA)	
Cache Buffer	64 MB	
NAND Flash Commercial Multilevel Cell (cMLC)	8 GB	
Number of Sectors	976,773,168	
Seek Time (typical reads)	Single Track:	2.0 ms
	Average:	12 ms
Height	0.268 +/- .008 in (6.8 +/- 0.2 mm)	
Width	2.750 +/- 0.010 in (69.85 +/- 0.25 mm)	
Length	3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)	
Weight	0.209 lb/95 g (max)	
Operating Temperature	32° to 140° F (0° to 60° C)	

HP 500 GB* 7.2K rpm SATA 6.0Gb/s 3.5” Hard Disk Drive

Capacity	500,107,862,016 bytes	
Rotational Speed	7,200 rpm	
Interface	Serial ATA 3.0 (6.0 Gb/s)	
Buffer Size	16 MB	
Logical Blocks	976,773,168	
Seek Time (typical reads, includes controller overhead, including settling)	Single Track:	2.0 ms
	Average:	11 ms
	Full-Stroke:	21 ms
Height (nominal)	1 in/2.54 cm	
Width (nominal)	Media diameter: 3.5 in/8.89 cm	
	Physical size: 4 in/10.2 cm	
Operating Temperature	41° to 131° F (5° to 55° C)	



Technical Specifications – Hard Disk and Solid State Storage

HP 120 GB* Solid State Drive		
Unformatted Capacity	120 GB	
Architecture	Multi Level Cell (MLC) NAND Flash with wear leveling 10 channel controller	
Interface	Serial ATA 2.0 (3.0 Gb/s)	
Dimensions (W x H x D)	2.74 x 0.37 x 4 in (6.98 x 0.95 x 10.2 cm)	
Weight	0.18 lb (80 g)	
Bandwidth Performance	Sustained Sequential Read:	Up to 250 MB/s
	Sustained Sequential Write:	Up to 70 MB/s
	Random Read:	Up to 35K IOPs
	Random Write:	Up to 6.6K IOPs
Latency	Read:	65-ms
	Write:	85-ms
Power	DC power requirement:	5 VDC 5%-100 mV ripple p-p
	Total power consumption:	0.15W (active); 0.075W (idle)
Useful Drive Life	35TB written, up to 20GB/day for 5 years	
Environmental (all conditions, non-condensing)	Operating Temperature:	32° to 158° F (0° to 70° C)
	Relative Humidity:	5% to 95%
	Maximum Wet Bulb Temperature (operating):	84° F (29° C)
	Shock:	1,500 G/0.5-ms
<p>* For solid state disk drives, GB means 1 billion bytes. Actual formatted capacity is less. Up to 36GB (for Windows 8.1) is reserved for system recovery software. 128GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features.</p> <p>** The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.</p>		

HP 128 GB* Solid State Drive	
Unformatted Capacity	128 GB*
Architecture	Multi Level Cell (MLC) NAND



Technical Specifications – Hard Disk and Solid State Storage

Interface	SATA 6 GB/sec	
Dimensions (W x H x D)	2.75 x 0.276 x 3.96 in (6.985 x 0.7 x 10.05 cm)	
Weight	0.16 lb (73 g)	
Bandwidth Performance	Sustained Sequential Read:	Up to 450 MB/ss
	Sustained Sequential Write:	Up to 260 MB/s
	Random Read (4KB):	up to 46K IOPs
	Random Write (4KB):	up to 56K IOPs
Latency	Read:	55ms (TYP)
	Write:	55ms (TYP)
Power	DC power requirement:	Min 4.5 V; Max 5.5 V
	Total power consumption:	160 mW (Active) ; <85 mW; (Idle)
Useful Drive Life	1.2 million device hours**	
Environmental (all conditions, non-condensing)	Operating Temperature:	32° to 158° F (0° to 70° C)
	Relative Humidity (operating):	5% to 95%
	Shock:	1,500 G/1.0 msec
Regulations	UL, CSA, EN 60950-2000, CISPR Pub 22 Class B, CNS 13438, AS/NZS CISPR 22:2002 Class B, Korea KCC, CE Mark	

* For solid state disk drives, GB means 1 billion bytes. Actual formatted capacity is less. Up to 36GB (for Windows 8.1) is reserved for system recovery software. 128GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features.
** The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.

HP 160 GB* Solid State Drive

Unformatted Capacity	160 GB*	
Architecture	Multi Level Cell (MLC) NAND	
Interface	SATA 3 GB/sec	
Dimensions (W x H x D)	2.74 x 0.37 x 4 in (6.98 x 0.95 x 10.2 cm)	
Weight	0.18 lb (80 g)	
Bandwidth Performance	Sustained Sequential Read:	Up to 250 MB/s
	Sustained Sequential Write:	Up to 70 MB/s



Technical Specifications – Hard Disk and Solid State Storage

	Random Read (4KB):	up to 35K IOPs
	Random Write (4KB):	up to 6.6K IOPs
Latency	Read:	65 ms
	Write:	85 ms
Power	DC power requirement:	5 VDC 5%-100 mV ripple p-p
	Total power consumption:	0.15 Watt (Active); 0.075 Watt (Idle)
Useful Drive Life	35TB written, up to 20GB/day for 5 years **	
Environmental (all conditions, non-condensing)	Operating Temperature:	32° to 158° F (0° to 70° C)
	Relative Humidity (operating):	5% to 95%
	Shock:	1,500 G/0.5 msec
Regulations	UL, CSA, EN 60950-2000, CISPR Pub 22 Class B, CNS 13438, AS/NZS CISPR 22:2002 Class B, Korea KCC, CE Mark	
* For solid state disk drives, GB means 1 billion bytes. Actual formatted capacity is less. Up to 36GB (for Windows 8.1) is reserved for system recovery software. 128GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features.		
** The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.		

HP 256 GB* SATA 2.5" Self-Encrypting (SED) Solid State Drive

Unformatted Capacity	256,186,209,271 bytes	
Architecture	Self-Encrypting (SED) Solid State Drive with 25nm MLC NAND Flash and SATA interface	
Interface	Serial ATA 2.0 (3.0 Gb/s)	
NAND Flash	25nm MLC NAND Flash	
Height	.275 in/7mm	
Width	2.75 in/69.85 mm	
Length	3.95 in/100.5 mm	
Weight	0.161 lb (73 g)	
Bandwidth Performance	Sustained Sequential 128k Read:	Up to 450 MB/s
	Sustained Sequential 128k Write:	Up to 260 MB/s
	Random 4k Read:	Up to 46K IOPs
	Random 4k Write:	Up to 56K IOPs



Technical Specifications – Hard Disk and Solid State Storage

Latency	Read:	55 μ s
	Write:	55 μ s
Power	SATA power consumption:	160 mW (active average); <85 mW (idle average)
Useful Drive Life	72TB written, up to 40GB/day for 5 years	
Environmental (all conditions, non-condensing)	Operating Temperature:	32° to 158° F (0° to 70° C)
	Relative Humidity:	5% to 95%
	Shock:	1,500 G/1 ms

HP 500 GB* 7.2K rpm SATA 6.0Gb/s 3.5” Hard Disk Drive

Capacity	500,107,862,016 bytes	
Rotational Speed	7,200 rpm	
Interface	Serial ATA 3.0 (6.0 Gb/s)	
Buffer Size	16 MB	
Logical Blocks	976,773,168	
Seek Time (typical reads, includes controller overhead, including settling)	Single Track:	2.0 ms
	Average:	11 ms
	Full-Stroke:	21 ms
Height (nominal)	1 in/2.54 cm	
Width (nominal)	Media diameter: 3.5 in/8.89 cm	
	Physical size: 4 in/10.2 cm	
Operating Temperature	41° to 131° F (5° to 55° C)	

HP 1 TB* 7.2K rpm SATA 6.0Gb/s 3.5” Hard Disk Drive

Capacity	1,000,204,886,016 bytes	
Rotational Speed	7,200 rpm	
Interface	Serial ATA 3.0 (6.0 Gb/s)	



Technical Specifications – Hard Disk and Solid State Storage

Buffer Size	16 MB	
Logical Blocks	1,953,525,168	
Seek Time (typical reads, includes controller overhead, including settling)	Single Track:	2.0 ms
	Average:	11 ms
	Full-Stroke:	21 ms
Height (nominal)	1 in/2.54 cm	
Width (nominal)	Media diameter: 3.5 in/8.89 cm	
	Physical size: 4 in/10.2 cm	
Operating Temperature	41° to 131° F (5° to 55° C)	

HP 2 TB* 7.2K rpm SATA 6.0Gb/s 3.5” Hard Disk Drive		
Unformatted Capacity	2 TB	
Rotational Speed	7,200 rpm	
Interface	SATA 6Gb/s NCQ	
Cache, Multisegmented (MB)	64 MB	
Seek Time (average)	Read	<8.5 ms
	Write	<9.5 ms
Height	1.028 in/26.11 mm	
Width	4.0 in/101.6 mm	
Depth	5.787 in/146.99 mm	
Weight	1.38 lb/626 g	
Operating Temperature	32° to 140° F (0° to 60° C)	



Technical Specifications - Removable Storage

HP Slim SuperMulti DVD Writer Drive*		
Height	12.7mm height	
Orientation	Either horizontal or vertical	
Interface type	SATA/ATAPI	
Disc recording capacity	Up to 8.5 GB DL or 4.7 GB standard	
Dimensions (W x H x D)	5.04 x 0.5 x 5.0 in (128 x 12.7 x 127 mm) without bezel	
Weight (max)	0.42 lb (190 g)	
Write speeds	DVD-RAM	Up to 5X
	DVD-R DL	Up to 6X
	DVD+R	Up to 8X
	DVD+RW	Up to 8X
	DVD+R DL	Up to 6X
	DVD-R	Up to 8X
	DVD-RW	Up to 6X
	CD-R	Up to 24X
Read speeds	CD-RW	Up to 24X
	DVD-RAM	Up to 5X
	DVD-RW, DVD+RW	Up to 8X
	DVD-R DL, DVD+R DL	Up to 8X
	DVD+R, DVD-R	Up to 8X
	DVD-ROM DL, DVD-ROM	Up to 8X
	CD-ROM, CD-R	Up to 24X
Access time (typical reads, including settling)	CD-RW	Up to 24X
	Random	DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)
	Full Stroke	DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)
Power	Stop Time	6 seconds (typical)
	Source	Slimline SATA DC power receptacle
	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p
Environmental conditions (operating - non-condensing)	DC Current	5 VDC (< 1000 mA typical, 1600 mA maximum)
	Temperature	41° to 122° F (5° to 50° C)
	Relative Humidity	10% to 80%
	Maximum Wet Bulb Temperature	84° F (29° C)



Technical Specifications - Removable Storage

HP Slim Blu-ray BDXL Drive*			
Height	12.7mm height		
Orientation	Either horizontal or vertical		
Interface type	SATA/ATAPI		
Disc recording capacity	Up to 128 GB QL, 100 GB TL, 50 GB DL or 25 GB standard SL		
Dimensions (W x H x D)	5.04 x 0.5 x 5.0 in (128 x 12.7 x 127 mm) without bezel		
Weight (max)	Up to 0.37 lb (170 g) without bezel		
		Triple-layer	Quadruple-layer
Write speeds	BD-R	Up to 4X	Up to 4X
	BD-RE	Up to 2X	Not supported
		Single-layer	Double-layer
	BD-R	Up to 6X	Up to 6X
	BD-RE	Up to 2X	Up to 2X
	DVD-R	Up to 8X	Up to 6X
	DVD-RW	Up to 6X	Not supported
	DVD+R	Up to 8X	Up to 6X
	DVD+RW	Up to 8X	Not supported
	DVD-RAM	Up to 5X	
	CD-R	Up to 24X	
	CD-RW	Up to 24X	
		Triple-layer	Quadruple-layer
	BD-R	Up to 4X	Up to 4X
	BD-RE	Up to 4X	Not supported
		Single-layer	Double-layer
	BD-ROM	Up to 6X	Up to 6X
	BD-R	Up to 6X	Up to 6X
Read speeds	BD-RE	Up to 6X	Up to 6X
	DVD-ROM	Up to 8X	Up to 8X
	DVD-R	Up to 8X	Up to 8X
	DVD-RW	Up to 8X	
	DVD+R	Up to 8X	Up to 8X
	DVD+RW	Up to 8X	
	BDMV (ACS Compliant Disc)	Up to 6X/2X (Read/Play)	
	DVD-RAM	Up to 5X	



Technical Specifications - Removable Storage

	DVD-Video (CSS Compliant Disc)	Up to 8X/4X (Read/Play)	
	CD-R/RW/ROM	Up to 24X	
	CD-DA(DAE)	Up to 20X/10X (Read/Play)	
Access time (typical reads, including settling)	Random	BD-ROM: 205 ms (typical), DVD-ROM: 185 ms (typical), CD-ROM: 165 ms (typical)	
	Full Stroke	BD-ROM: 350 ms (typical), DVD-ROM: 345 ms (typical), CD-ROM: 340 ms (typical)	
Power	Source	Slimline SATA DC power receptacle	
	DC Power Requirement	5 VDC \pm 5%-100 mV ripple p-p	
	DC Current	5 VDC - 1200 mA typical, 2000 mA maximum	
Environmental conditions (operating - non-condensing)	Temperature	41° to 122° F (5° to 50° C)	
	Relative Humidity	10% to 80%	
	Maximum Wet Bulb Temperature	84° F (29° C)	

HP Slim DVD-ROM Drive*

Height	12.7mm		
Orientation	Either horizontal or vertical		
Interface type	SATA/ATAPI		
Dimensions (W x H x D)	5.04 x 0.5 x 5.0 in (128 x 12.7 x 127 mm) without bezel		
Weight (max)	Up to 0.37 lb (170 g) without bezel		
Read speeds	DVD+R/-R/+RW/-RW/+R DL /-R DL	Up to 8X	
	DVD-ROM	Up to 8X	
	CD-ROM, CD-R	Up to 24X	
	CD-RW	Up to 24X	
Access time (typical reads, including settling)	Random	DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)	
	Full Stroke	DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)	
Power	Source	Slimline SATA DC power receptacle	
	DC Power Requirement	5 VDC \pm 5%-100 mV ripple p-p	
	DC Current	5 VDC - <1000 mA typical, < 1600 mA maximum	
Environmental (all conditions non-condensing)	Temperature	41° to 122° F (5° to 50° C)	
	Relative Humidity	10% to 80%	
	Maximum Wet Bulb Temperature (operating)	84° F (29° C)	



Technical Specifications - Removable Storage

*Duplication of copyrighted material is strictly prohibited. Actual speeds may vary. Double Layer media compatibility will widely vary with some home DVD players and DVD-ROM drives. Note that DVD-RAM cannot read or write to 2.6GB Single Sided/5.2 Double Sided-Version 1.0 Media.



Technical Specifications – Memory

System Memory Support

The HP EliteDesk 705 G1 Business PC supports DDR3/DDR3L protocols with two independent, 64-bit wide channels each accessing one or two DIMMs.

- Two channels of non-ECC DDR3/DDR3L unbuffered dual in-line memory modules (UDIMM) or DDR3/DDR3L unbuffered small outline dual in-line memory modules (SO-DIMM) with a maximum of two DIMMs per channel
- Single-channel and dual-channel memory organization modes
- Data burst length of eight for all memory organization modes
- Memory data transfer rates of up to 1600 MT/s; actual supported data transfer rate determined by the configured processor.
- 64-bit wide channels
- DDR3/DDR3L system memory I/O voltage of 1.5V
- Theoretical maximum memory bandwidth of:
 - 21.3 GB/s in dual-channel mode assuming 1333 MT/s
 - 25.6 GB/s in dual-channel mode assuming 1600 MT/s
 - 25.6 GB/s in dual-channel mode assuming 1600 MT/s

Platform Memory Support

- The Small Form Factor (SFF) and Microtower (MT) platforms support up to four (4) industry-standard DDR3-SDRAM DIMMs.
- The Desktop Mini (DM) supports up to two (2) industry-standard DDR3-SDRAM SO-DIMMs.

CAUTION: You must shut down the computer and disconnect the power cord before adding or removing memory modules. Regardless of the power-on state, voltage is always supplied to the memory modules as long as the computer is plugged in to an active AC outlet. Adding or removing memory modules while voltage is present may cause irreparable damage to the memory modules or system board.

NOTE: For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.



Technical Specifications – Networking and Communications

Broadcom NetXtreme Gigabit Ethernet Plus (integrated)		
Connector	RJ-45	
System Interface	Integrated on PCA	
Controller	Broadcom BCM5762 GbE	
Memory	24 KB FIFO packet buffer memory Two Queues (Tx & Rx)	
Data rates supported	10/100/1000 Mbps	
IEEE Compliance	802.1P 802.1Q 802.1as/1588 802.3 802.3ab 802.3az 802.3u	
Bus architecture	PCI Express and SMBus	
Data transfer mode	PCIe-based interface for active state operation (S0 state) and SMBus for host and management traffic (Sx low power state)	
Power requirement	Requires 3.3Vdc with integrated regulators Thermal Design Power (TDP) 0.535 Watts	
Boot ROM support	Yes	
Network transfer mode	Full-duplex	
	Half-duplex (not supported for the 1000BASE-T transceiver)	
Network transfer rate	10BASE-T (half-duplex) 10 Mbps	
	10BASE-T (full-duplex) 20 Mbps	
	100BASE-TX (half-duplex) 100 Mbps	
	100BASE-TX (full-duplex) 200 Mbps	
	1000BASE-T (full-duplex) 2000 Mbps	
Environmental	Operating Temperature:	0° to 85° C
	Operating Humidity:	60% RH



Technical Specifications – Networking and Communications

Management	WOL, auto MDI crossover, PXE, Multi-port teaming, RSS, Advanced cable diagnostic, Smart speed operation
Alerting	ASF 2.0 support; AMT 7.0 support

Intel® Ethernet I210-T1 Gigabit Network Adapter

Connector	RJ-45
System Interface	PCI Express x1
Controller	Intel® I210 Gigabit Ethernet Controller
Memory	Integrated Dual 48K configurable transmit receive FIFO Buffers
Data rates supported	10/100/1000 Mbps
IEEE Compliance	802.1P 802.1Q 802.2 802.3 802.3AB 802.3u 802.3x flow control
Bus architecture	PCI-E 2.1
Data path width	X1, 250 MB/s, Bi-directional interface
Data transfer mode	Bus-master DMA
Hardware certifications	FCC, B, CE, TUV-c, TUVus Mark Canada and United States, TUV-GS Mark for European Union
Power requirement	Aux 3.3 V, 3.0 Watts in 1000 base-T and 1.0 Watts in 100 Base-T
Boot ROM support	Yes 10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps
Network transfer rate	10BASE-T (half-duplex) 10 Mbps
	10BASE-T (full-duplex) 20 Mbps
	100BASE-TX (half-duplex) 100 Mbps
	100BASE-TX (full-duplex) 200 Mbps
	1000BASE-T (full-duplex) 2000 Mbps (actual rate limited by PCI bus)



Technical Specifications – Networking and Communications

Environmental	Operating Temperature:	32° to 132° F (0° to 55° C)
	Operating Humidity:	85% at 131° F (55° C)
Management	WOL, PXE, DMI, WFM 2.0	
Intel Dual Band Wireless-N 7260 802.11 a/b/g/n (2x2) Wireless Network Interface Connection		
Wireless LAN Standards	IEEE 802.11a/b/g/n	
Interoperability	Wi-Fi certified (802.11 a/b/g/n WMM, WPA, WPA2 and WPS)	
	Cisco Compatible Extensions Program compliant with Microsoft Windows 7, Windows Vista and XP.	
	NOTE: WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista.	
Frequency Band	802.11b/g/n	2.402-2.482 GHz
	802.11a/n	4.9 - 4.95 GHz (Japan) 5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz
Antenna Structure	2 transmit; 2 receive (2x2)	
Data Rates	802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)	
Modulation	Direct Sequence Spread Spectrum CCK, BPSK, QPSK, 16-QAM, 64-QAM	
Security	<ul style="list-style-type: none"> • IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only • AES-CCMP: 128 bit in hardware • 802.1x authentication • WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. • WPA2 certification • IEEE 802.11i • Cisco Certified Extensions, all versions through CCX4 and CCX Lite • WAPI 	
	Note: Check latest software/driver release for updates on supported security features.	
Sub-channels	Multinational support with frequency bands and channels compliant to local regulations.	
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)	



Technical Specifications – Networking and Communications

Roaming	IEEE 802.11 compliant roaming between band Access Points	
Output Power	<ul style="list-style-type: none"> 2.4G: +13.5dBm minimum 5G: +12dBm minimum 	
	Note: Maximum output power may vary by country according to local regulations.	
Power Consumption	Transmit: 2.0 Watts	
	Receive: 1.6 Watts	
	Idle mode: 250 mW (WLAN associated) In Power Save Polling mode and on battery power.	
	Idle mode: 100 mW (WLAN unassociated)	
	Radio off: 100 mW (WLAN unassociated)	
Power Management	ACPI compliant power management 802.11 compliant power saving mode	
Receiver Sensitivity Note: Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).	802.11g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm (48 Mbps), -74 dBm (54 Mbps)	
	802.11b:-95 dBm (1 Mbps), -93 dBm (2 Mbps), -91 dBm (5.5 Mbps), -88 dBm (11 Mbps)	
	802.11g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm (48 Mbps), -74 dBm (54 Mbps)	
Antenna Connections	2 U.FL type connectors (output impedance of 50 ± 2 ohms)	
Form Factors	PCI-Express Half-MiniCard	
Weight	0.0068 lb (3.1 g)	
Dimensions	0.12 x 1.06 x 1.18 in (3.1 x 26.8 x 30.0 mm)	
Operating Voltage	3.3V +/- 9%	
Temperature	Operating:	14° to 158° F (-10° to 70° C)
	Non-operating:	-40° to 176° F (-40° to 80° C)
Humidity	Operating:	10% to 90% (non-condensing)
	Non-operating:	5% to 90% (non-condensing)
Altitude	Operating:	0 to 10,000 ft (3,048 m)
	Non-operating:	0 to 50,000 ft (15,240 m)
LED Activity	LED Amber - Radio OFF; LED White - Radio ON	
HP WLAN 802.11 a/b/g/n 2x2 Dual Band PCIe x1 WLAN/Bluetooth Card		
Wireless LAN Standards	IEEE 802.11a/b/g/n	
Interoperability	Wi-Fi certification	
	BQE certification of the Bluetooth component	



Technical Specifications – Networking and Communications

	CCXv1, v2, v3, v4, v5 CCX certified (Cisco Client Extensions)	
	NOTE: WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista.	
Frequency Band	802.11b/g/n	2.402-2.482 GHz
	802.11a/n	4.9 - 4.95 GHz (Japan) 5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz
Antenna Structure	2 transmit; 2 receive (2x2) Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications.	
Data Rates	<ul style="list-style-type: none"> 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: card will support rates for NSS=1 and NSS=2 for RX and TX for 20 and 40 MHz channels. Short and long guard interval shall be supported. 	
Security	<ul style="list-style-type: none"> IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification IEEE 802.11i Cisco Certified Extensions, all versions through V5 WAPI 	
	Note: Check latest software/driver release for updates on supported security features.	
Roaming	IEEE 802.11 compliant roaming between band Access Points	
Output Power	<ul style="list-style-type: none"> +13.5 dBm minimum Maximum output power must be able to achieve modular regulatory certification peak gain of +3dBi at 2.4GHz and +5dBi at 5GHz 	
	Note: Maximum output power may vary by country according to local regulations.	
Power Consumption	Transmit: 2.0 Watts	
	Receive: 1.6 Watts	
	Idle mode: 250 mW (WLAN associated)	
	Idle mode: 100 mW (WLAN unassociated)	
	Radio off: 75 mW (WLAN unassociated)	



Technical Specifications – Networking and Communications

Bluetooth Power Consumption	Peak operating: 330 mW																											
	Receive: 230 mW																											
	USB selective suspend: 17 mW																											
Power Management	ACPI and PCI Express bus compliant power management 802.11 compliant power saving mode Supports USB selective suspend and resume of the Bluetooth component through the USB control signals.																											
Receiver Sensitivity	802.11b	<table border="1"> <thead> <tr> <th>Sensitivity (dBm)</th> <th>Rate (Mbps)</th> <th>Modulation and Coding Rate</th> </tr> </thead> <tbody> <tr> <td>-95</td> <td>1</td> <td>BPSK</td> </tr> <tr> <td>-93</td> <td>2</td> <td>QPSK</td> </tr> <tr> <td>-91</td> <td>5.5</td> <td>CCK</td> </tr> <tr> <td>-88</td> <td>11</td> <td>CCK</td> </tr> </tbody> </table>	Sensitivity (dBm)	Rate (Mbps)	Modulation and Coding Rate	-95	1	BPSK	-93	2	QPSK	-91	5.5	CCK	-88	11	CCK											
		Sensitivity (dBm)	Rate (Mbps)	Modulation and Coding Rate																								
		-95	1	BPSK																								
		-93	2	QPSK																								
		-91	5.5	CCK																								
-88	11	CCK																										
802.11a/g	<table border="1"> <thead> <tr> <th>Sensitivity (dBm)</th> <th>Rate (Mbps)</th> <th>Modulation and Coding Rate</th> </tr> </thead> <tbody> <tr> <td>-90</td> <td>6</td> <td>BPSK - 1/2</td> </tr> <tr> <td>-89</td> <td>9</td> <td>BPSK - 3/4</td> </tr> <tr> <td>-87</td> <td>12</td> <td>QPSK - 1/2</td> </tr> <tr> <td>-85</td> <td>18</td> <td>QPSK - 3/4</td> </tr> <tr> <td>-82</td> <td>24</td> <td>16 QAM - 1/2</td> </tr> <tr> <td>-79</td> <td>36</td> <td>16 QAM - 3/4</td> </tr> <tr> <td>-76</td> <td>48</td> <td>64 QAM - 2/3</td> </tr> <tr> <td>-74</td> <td>54</td> <td>64 QAM - 3/4</td> </tr> </tbody> </table>	Sensitivity (dBm)	Rate (Mbps)	Modulation and Coding Rate	-90	6	BPSK - 1/2	-89	9	BPSK - 3/4	-87	12	QPSK - 1/2	-85	18	QPSK - 3/4	-82	24	16 QAM - 1/2	-79	36	16 QAM - 3/4	-76	48	64 QAM - 2/3	-74	54	64 QAM - 3/4
	Sensitivity (dBm)	Rate (Mbps)	Modulation and Coding Rate																									
	-90	6	BPSK - 1/2																									
	-89	9	BPSK - 3/4																									
	-87	12	QPSK - 1/2																									
	-85	18	QPSK - 3/4																									
	-82	24	16 QAM - 1/2																									
	-79	36	16 QAM - 3/4																									
	-76	48	64 QAM - 2/3																									
	-74	54	64 QAM - 3/4																									
802.11n	<table border="1"> <thead> <tr> <th>Sensitivity (dBm)</th> <th>Rate (Mbps)</th> <th>Modulation and Coding Rate</th> </tr> </thead> <tbody> <tr> <td>-69</td> <td>150</td> <td>64 QAM - 5/6</td> </tr> <tr> <td>-66</td> <td>300</td> <td>64 QAM - 5/6</td> </tr> </tbody> </table>	Sensitivity (dBm)	Rate (Mbps)	Modulation and Coding Rate	-69	150	64 QAM - 5/6	-66	300	64 QAM - 5/6																		
	Sensitivity (dBm)	Rate (Mbps)	Modulation and Coding Rate																									
	-69	150	64 QAM - 5/6																									
-66	300	64 QAM - 5/6																										
Form Factors	PCI-Express Half-MiniCard																											
Weight	0.1133 oz (3.212 g)																											
Dimensions	1.04 x 1.17 x 0.042 in (26.65 x 29.85 x 1.067 mm)																											
Operating Voltage	3.3V +/- 9%																											
Temperature	Operating: Non-operating:	14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C)																										
Humidity	Operating: Non-operating:	10% to 90% (non-condensing) 5% to 95% (non-condensing)																										
Altitude	Operating: Non-operating:	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)																										



Technical Specifications - Audio

High Definition Audio	
Type	Integrated
HD Stereo Codec	Realtek 2-channel ALC221 codec
Audio I/O Ports	Front microphone-In (150-K ohm Input Impedance)
	Rear Line-In/Microphone input (150-K ohm Input Impedance, function is configurable by audio driver)
	Rear Line-Out* (190 ohms Output Impedance, expects at least a 10-K ohm load)
	Front Headphone-Out (0.5 Ohm Output Impedance, expects at least a 32 ohm load) Front Microphone/Headphone jack is re-task able to provide Microphone input, line-in or Headphone output to support connecting two headphones to the front of the system. When configured as a second front headphone output, both front headphone outputs are always driven with the same signal.
	All ports are 3.5mm
Internal Speaker Amplifier	1.5W amplifier for the internal speaker only. External speakers must be powered externally. Rear Line-in audio port is re-taskable as either Line-in or Microphone-In.
Multi-streaming Capable	Multi-streaming can be enabled in the Realtek control panel to allow independent audio streams to be sent to/from the front and rear jacks.
Sampling	8 kHz - 192 kHz
Wavetable Syntheses	Yes – Uses OS soft wavetable
Analog Audio	Yes
# of Channels on Line-Out	Stereo (Left & Right channels)
Internal Speaker	Yes
External Speaker Jack	Yes



Technical Specifications - Input/Output Devices

HP USB Keyboard		
Physical characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country)
	Dimensions (L x W x H)	18.12 x 6.47 x 0.96 in (46.03 x 16.43 x 2.44 cm)
	Weight	2 lb (0.9 kg)
Electrical	Operating voltage	+ 5VDC \pm 5%
	Power consumption	50-mA maximum (with three LEDs ON)
	System interface	USB Type A plug connector
	ESD	CE level 4, 15-kV air discharge
	EMI - RFI	Conforms to FCC rules for a Class B computing device
	Microsoft® PC 99 - 2001	Functionally compliant
Mechanical	Keycaps	Low-profile design
	Switch actuation	55-g nominal peak force with tactile feedback
	Switch life	20 million keystrokes (using Hasco modified tester)
	Switch type	Contamination-resistant switch membrane
	Key-leveling mechanisms	For all double-wide and greater-length keys
	Cable length	6 ft (1.8 m)
	Microsoft PC 99 - 2001	Mechanically compliant
Environmental	Acoustics	43-dBA maximum sound pressure level
	Operating temperature	50° to 122° F (10° to 50° C)
	Non-operating temperature	-22° to 140° F (-30° to 60° C)
	Operating humidity	10% to 90% (non-condensing at ambient)
	Non-operating humidity	20% to 80% (non-condensing at ambient)
	Operating shock	40 g, six surfaces
	Non-operating shock	80 g, six surfaces
	Operating vibration	2-g peak acceleration



Technical Specifications - Input/Output Devices

	Non-operating vibration	4-g peak acceleration
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence
	Drop (in box)	30 in (76.2 cm) on concrete, 16-drop sequence
Approvals	UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, KC	
Ergonomic compliance	ANSI HFS 100, ISO 9241-4, and TUVGS	
Kit contents	Keyboard	Installation Guide
	Warranty Card	Safety and Comfort Guide

HP PS/2 Keyboard		
Physical Characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country)
	Dimensions (L x W x H)	18.22 x 6.47 x 1.1 in (46.28 x 16.43 x 2.79 cm)
	Weight	2 lb (0.9 kg) minimum
Electrical	Operating voltage	+ 5VDC \pm 10%
	Power consumption	50-mA maximum (with three LEDs ON)
	System interface	PS/2 6-pin mini din connector
	ESD	CE level 4, 15-kV air discharge
	EMI - RFI	Conforms to FCC rules for a Class B computing device
	Microsoft PC 99 - 2001	Functionally compliant
	Keycaps	Low-profile design
	Switch actuation	55-g nominal peak force with tactile feedback
	Switch life	20 million keystrokes (using Hasco modified tester)
	Switch type	Contamination-resistant switch membrane
	Key-leveling mechanisms	For all double-wide and greater-length keys
	Cable length	6 ft (1.8 m)
Microsoft PC 99 - 2001	Mechanically compliant	
Environmental	Acoustics	50-dBA maximum sound pressure level



Technical Specifications - Input/Output Devices

	Operating temperature	32° to 104° F (0° to 40° C)
	Non-operating temperature	-22° to 149° F (-30° to 65° C)
	Operating humidity	15% to 80% (non-condensing at ambient)
	Non-operating humidity	15% to 90% (non-condensing at ambient)
	Operating shock	N/A
	Non-operating shock	65 inch 2.9 ms, six surface; 30g 266 inch/second; 50g 266 inch/second six surface
	Operating vibration	2-g peak acceleration
	Non-operating vibration	Starting at 5 Hz, vary the frequency of vibration from 5 to 500 Hz and back to 5 Hz at a Logarithmic sweep rate of 1 octave per minute.
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence
	Drop (in box)	29.93 in (76 cm) on concrete, 16-drop sequence
Approvals	CUL, ICES-003 Class B, FCC, CE Mark, TUV GS, VCCI, BSMI, C-Tick, KC	
Ergonomic compliance	ANSI HFS 100, ISO 9241-4, and TUVGS	

HP USB Smart Card (CCID) Keyboard

Key Benefits:	<ul style="list-style-type: none"> • Protects against unauthorized access with smart card technology • Delivers even greater security when combined with a HP ProtectTools smart card and the HP ProtectTools Security Software • Combination of username and password or pin with a smart card or security token • Secures online transactions using digital signatures and certificates • Conforms to industry standards for ease of setup and use • Delivers long product life and quiet operation with high-impact materials and lubricated keys • Spill drain feature 	
Physical Characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country)
	Form factor	USB basic smart card keyboard
	Colors	Carbonite/Silver
	Dimensions (H x W x D)	18.2 x 6.3 x 1.3 in (46.3 x 16.1 x 3.3 cm)
	Weight	2 lb (0.9 kg) minimum



Technical Specifications - Input/Output Devices

Electrical	Operating voltage	+ 5VDC \pm 5%
	Power consumption	100-mA maximum (with four LEDs ON)
	System interface	USB Type A plug connector
	ESD	CE level 4, 15-kV air discharge
	EMI - RFI	Conforms to FCC rules for a Class B computing device
	Microsoft PC 99 - 2001	Functionally compliant
Mechanical	Languages	30+ available
	Keycaps	Standard design
	Switch actuation	55 g nominal peak force with tactile feedback
	Switch life	20 million keystrokes (using Hasco modified tester)
	Switch type	Contamination-resistant membrane
	Key-leveling mechanisms	For all double-wide and greater-length keys
	Cable length	6 ft (1.8 m)
	Microsoft PC 99 - 2001	Mechanically compliant
Environmental	Acoustics	43-dBA maximum sound pressure level
	Operating temperature	50° to 122° F (10° to 50° C)
	Non-operating temperature	-22° to 140° F (-30° to 60° C)
	Operating humidity	10% to 90% (non-condensing at ambient)
	Non-operating humidity	20% to 80% (non-condensing at ambient)
	Operating shock	40 g, six surfaces
	Non-operating shock	80 g, six surfaces
	Operating vibration	2-g peak acceleration
	Non-operating vibration	4-g peak acceleration
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence
	Drop (in box)	42 in (107 cm) on concrete, 16-drop sequence
SmartCard Function	Support	All ISO 7816 smart cards



Technical Specifications - Input/Output Devices

	Interface	Reads from and writes to all ISO7816-1, 2, 3, 4 memory and microprocessor smart cards (T=0, T=1)		
	Chipset	SCM STCII		
	Standard APIs supported	PC/SC, EMV2000, SET		
	Power	USB Port		
		Short circuit detection (protects smart card and reader)		
		Power supply compliant with ISO7816 and EMV (5V, 60 mA)		
		Supports 3-V and 5-V cards		
	Power consumption	100-mA maximum draw		
	Communication	From card	9600 bps to 330,000 bps	
		From computer	12 Mbps (USB transfer speed)	
	Landing mechanism	Contact device	Friction contact	
		Card insertions rating	Up to 100,000 insertion cycles	
	Interface modes	CCID protocol		
	Reader performance interface	USB connection		
Electro-magnetic standards	Europe	2004/108/EC		
	USA	USAFCC part 15		
Approvals	CE-Mark, UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC, EMV2000, USB-IF			
Ergonomic Compliance	ISO 9241-4, TUVGS			
Kit Contents	Keyboard, I/O Security and Documentation CD, warranty card			
HP USB PS/2 Washable Keyboard				
Physical Characteristics	Keys	104 (US) Layout, 105 (EU) layout – depending upon country		
	Dimensions (L x W x H)	17.67x 6.62 x 1.38 in (449 x 168 x 35 mm)		
	Weight	1.7 lb (0.77 kg) minimum		
Electrical	Operating voltage	+ 5VDC ±5%		



Technical Specifications - Input/Output Devices

	Power consumption	50-mA maximum (with three LEDs ON)
	System interface	USB Type A plug connector
	ESD	CE level 4, 15-kV air discharge
	EMI - RFI	Conforms to FCC rules for a Class B computing device
	Microsoft PC 99 - 2001	Functionally compliant
Mechanical	Keycaps	Stepped -profile design
	Switch actuation	55-g nominal peak force with tactile feedback
	Switch life	20 million keystrokes
	Switch type	Contamination-resistant switch membrane
	Key-leveling mechanisms	For all double-wide and greater-length keys
	Cable length	7 ft (2.2 m)
	Microsoft PC 99 - 2001	Mechanically compliant
	Acoustics	43-dBA maximum sound pressure level
Environmental	Operating temperature	50° to 122° F (10° to 50° C)
	Non-operating temperature	4° to 149° F (-20° to 65° C)
	Operating humidity	10% to 95% (non-condensing at ambient)
	Non-operating humidity	0% to 95% (non-condensing at ambient)
	Operating shock	40 g, six surfaces
	Non-operating shock	80 g, six surfaces
	Operating vibration	2-g peak acceleration
	Non-operating vibration	4-g peak acceleration
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence
	Drop (in box)	42 in (107 cm) on concrete, 16-drop sequence
Approvals	UL, cUL, FCC, CE, TUV GS, VCCI, BSMI, C-Tick, KCC, USB-IF, WHQL, EN/IEC 60601-1, IP66/NEMA4X	
Ergonomic compliance	ANSI HFS 100, ISO 9241-4, and TUVGS	

HP Wireless Keyboard and Mouse

Keyboard	Dimensions (H x L x W)	1.09 x 18.1 x 6.47 in (27.87 x 460.3 x 164.3 mm)
	Weight – Without Two AA Alkaline Batteries	1.94 lb (880 g)
Mouse	Dimensions (H x L x W)	1.46 x 4.53 x 2.47 in (37 x 115 x 62.9 mm)
	Weight – Without Two AA Alkaline Batteries	0.15 lb (67 g)
Receiver	Dimensions (H x L x W)	0.33x 1.79 x 0.72 in (8.4 x 45.5 x 18.4 mm)
	Weight	0.21 oz (5.9 g)



Technical Specifications - Input/Output Devices

	Cable Length – Minimum	6 ft (1.8 m)
	Range	32.8 ft (10 m)
System Requirements	Available USB port for the receiver CD-ROM Drive	
Approvals	Product Safety	UL; CSA /TUV (Europe only); CE Mark; CB Report
	Ergonomics	ANSI; ISO (Europe only); GS Mark (Germany only)
	EMC	FCC; CE; ACA (-tick); BSMI; KC ; VCCI
	CE Mark	EN 55022:2010; EN 55024; EN 301489-1; EN 61000
	Design Guidelines for PCs	PC 99 – connector overmold colors; PC 2001 – full functionality
	Telecom	All local telecom requirements and approvals for intended markets
	USA	FCC Title 47 CFR, Par 15, Subpart C; other local requirements
	Country Support	US, Belgium, Switzerland, Spain, Denmark, Netherlands, France, Germany, Italy, Portugal, Sweden, Norway, Finland, UK, Poland, Czech Republic, Turkey, Greece, Austria, Bulgaria, Cyprus, Estonia, Hungary, Ireland, Latvia, Lithuania, Luxemburg, Malta, Romania, Slovakia, Slovenia, Vietnam, HK, Australia, NZ, Malaysia, Singapore, Indonesia, Philippines, Thailand, Canada, China, Japan, Korea, Taiwan, India, Venezuela, Ecuador, Russia, Ukraine, Israel, Croatia, United Arab Emirates, Peru, Brazil, Chile, Argentina, Mexico, South Africa, and up to 193 countries worldwide.
Environmental	Keyboard contains 25% post-consumer recycled plastic material.	

HP PS/2 Mouse		
Dimensions (H x L x W)	1.46 x 2.48 x 4.53 in (3.70 x 6.29 x 11.50 cm)	
Weight	3.53 oz (100g; +10g/- 5 g)	
Environmental	Operating temperature	-32° to 104°F (0° to 40° C)
	Non-operating temperature	-4° to 140°F (-20° to 60° C)
	Operating humidity	10% to 90% (non condensing at ambient)
	Non-operating humidity	10% to 90% (non condensing at ambient)



Technical Specifications - Input/Output Devices

	Operating shock	40 g, 6 surfaces
	Non-operating shock	80 g, 6 surfaces
	Operating vibration	2 g peak acceleration
	Non-operating vibration	4 g peak acceleration
	Drop (out of box)	80 cm height onto asphalt tile over concrete or equivalent, 5-drop in 5 direction except the cable face
Electrical	Operating voltage	5 VDC \pm 10%
	Power consumption	100mA
	System consumption	PS/2 mini-din connector
	ESD	CE level 4, 15 kV air discharge
	EMI-RFI	Conforms to FCC rules for a Class B computing device
	Microsoft PC99 - 2001	Functionally compliant
Mechanical	Resolution	800 DPI
	Tracking speed	10 in/s (25.4 cm/s) maximum
	Acceleration	\pm 15%
	Switch actuation	65 \pm 20 gf
	Switch life	3,000,000 operations (using Hasco modified tester)
	Switch type	Low force micro-switches
	Tracking mechanism life	80 km
	Cable length	6 ft (1.8 m)
	Microsoft PC99 - 2001	Mechanically compliant
Scroll wheel	Width	6 mm
	Diameter	22.5 \pm 0.2 mm
	Maximum rotation force	50 gf-cm
	Switch type	Light force micro-switch
	Switch life	1 million operations



Technical Specifications - Input/Output Devices

	Mechanical life	Minimum 200,000 revolutions
Regulatory Approvals	UL/cUL, FCC, CE Mark, TUV/GS, VCCI, KCC, BSMI, C-Tick	

HP USB Mouse		
Dimensions (H x L x W)	1.5 x 4.5 x 2.5 in (3.7 x 11.5 x 6.3 cm)	
Weight	0.22 lb (0.10 kg)	
Cable length	70.9 in (180 cm)	
System requirements	Available USB port	

HP USB 1000dpi Laser Mouse		
Dimensions (H x L x W)	1.47 x 4.53 x 2.47 in (37.3 x 114.97 x 62.86 mm)	
Weight	3.360 oz (102g)	
Cable length	70.9 in (180 cm)	
System requirements	Available USB port	
Environmental	Operating Temperature	32° to 104° F (0° to 40° C)
	Non-operating Temperature	-4° to 140° F (-20° to 60° C)
	Operating Humidity	10% to 90% (non-condensing at ambient)
Mechanical	Resolution	1000dpi
	Tracking Speed	45 cm/sec
	Cable Length	70.9 in (180 cm)

HP USB PS/2 Washable Mouse		
Dimensions (H x L x W)	1.56 x 2.44 x 4.61 in (3.95 x 6.21 x 11.7 cm)	



Technical Specifications - Input/Output Devices

Weight	4.44 oz (126 g)	
Environmental	Operating temperature	-32° to 104°F (0° to 40° C)
	Non-operating temperature	-4° to 140°F (-20° to 60° C)
	Operating humidity	10% to 90% (non-condensing at ambient)
	Non-operating humidity	10% to 90% non-condensing
	Operating shock	40 g, 6 surfaces
	Non-operating shock	80 g, 6 surfaces
	Operating vibration	2 g peak acceleration
	Non-operating vibration	4 g peak acceleration
	Drop (out of box)	80 cm height onto asphalt tile over concrete or equivalent, 5-drop in 5 direction except the cable face
Electrical	Operating voltage	5 VDC ± 10%
	Power consumption	100mA
	System consumption	PS/2 mini-din connector or USB
	ESD	CE level 2 8 kV air discharge
	EMI-RFI	Conforms to FCC rules for a Class B computing device
	Microsoft PC99 - 2001	Functionally compliant
Mechanical	Resolution	1000 ± 20% DPI
	Tracking speed	14 in/s (35.56 cm/s) maximum
	Acceleration	2 g
	Switch actuation	70 g nominal peak force
	Switch life	3,000,000 operations (using Hasco modified tester)



Technical Specifications - Input/Output Devices

	Switch type	Low force micro-switches
	Tracking mechanism life	8.8 ft total 70 cm+ 2m extension
	Cable length	Mechanically compliant
	Microsoft PC99 - 2001	1000 ± 20% DPI
Scroll wheel	Width	6 mm
	Diameter	1 in (25.4 mm)
	Maximum rotation force	48 rats/sec
	Switch type	Light force micro-switch
	Switch life	3 million operations
	Mechanical life	Minimum 200,000 revolutions
Regulatory Approvals	FCC, CE Mark, ICES-003-B, IP66/NEMA4X	



Technical Specifications – Power

Unit Environment and Operating Conditions

General Unit Operating Guidelines

- Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is operated within the specified operating range.
- Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's re-circulated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign matter can block the vents and limit the airflow.
- If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply.

Temperature Range	Operating: 50° to 95° F (10° to 35° C)* Non-operating: –22° to 140° F(–30° to 60° C)
Relative Humidity	Operating: 10% to 90% (non-condensing at ambient) Non-operating: 5% to 95% (non-condensing at ambient)
Maximum Altitude (unpressurized)	Operating: 10,000 ft (3048 m) Non-operating: 30,000 ft (9144 m)

*Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.

Power Supply

	DM	SFF	MT
Standard Efficiency	90W active PFC 89% efficient	240W active PFC	280W active PFC 280W active PFC
80 PLUS Bronze	N/A	N/A	82/85/82% efficient at 20/50/100% load (115V) 82/85/82% efficient at 20/50/100% load (230V) 240W active PFC 280W active PFC
80 PLUS Gold	N/A	87/90/87% efficient at 20/50/100% load (115V) 89/91/90% efficient at 20/50/100% load (230V) 240W active PFC	87/90/87% efficient at 20/50/100% load (115V) 88/91/88% efficient at 20/50/100% load (230V) 280W active PFC
80 PLUS Platinum	N/A	90/92/89% efficient at 20/50/100% load (115V) 90/93/91% efficient at 20/50/100% load (230V)	90/92/89% efficient at 20/50/100% load (115V) 91/93/90% efficient at 20/50/100% load (230V)
Operating Voltage Range	90 - 264 VAC	90 - 264 VAC	90 - 264 VAC
Rated Voltage Range	100 - 240 VAC	100 - 240 VAC	100 - 240 VAC
Rated Line Frequency	50/60 Hz	50/60 Hz	50/60 Hz
Operating Line Frequency	47 – 63 Hz	47 – 63 Hz	47 – 63 Hz
Rated Input Current	N/A	4A	3.6A



Technical Specifications – Power

Rated Input Current with Energy Efficient* Power Supply	N/A	4A	3.6A
DC Output	+19.5V	N/A	N/A
Current Leakage (NFPA 99)	< 250 μ A	< 275 μ A	< 275 μ A
Power Supply Fan	N/A	92=>70mm variable speed	80mm variable speed
Power cord length	N/A	6.0 ft. (1.83 m)	6.0 ft. (1.83 m)
External Power Adapter			
Total Cord Length	12 ft 8 in	N/A	N/A



Technical Specifications – Weights & Dimensions

Weights & Dimensions

(configured with 1 HDD & 1 ODD; DM configured with 1 HDD only)

	<u>DM</u>	<u>SFF</u>	<u>MT</u>
Chassis (W x H x D)	6.9 x 1.3 x 7.0 in 175 x 34 x 177 mm	13.3 x 3.95 x 14.9 in 338 x 100 x 380 mm	14.0 x 6.7 x 13.4 in 355 x 170 x 340 mm
System Volume	62.79 cu in 1.05 L	782.7 cu in 12.8 L	1252 cu in 20.5 L
System Weight*	2.9 lb 1.3 kg	16.7 lb 7.6 kg	14.0 lb 6.35 kg
Max Supported Weight (desktop orientation)	N/A	77.0 lb 35.0 kg	N/A
Tower Stand (H x W x D)	77x 4.6 x 6.3 in 19.5 x 117 x 160 mm Weight: 47g/ .1 lbs.	1.1 x 7.0 x 7.9 in 29 x 178 x 200 mm	N/A
Packaging (H x W x D)	7.8 x 11.4 x 19.7 in 198 x 290 x 500 mm	9.0 x 19.7 x 23.4 in 229 x 500 x 594 mm	11.7 x 20.3 x 18.8 in 299 x 517 x 478 mm
Shipping Weight	9.0 lb. 4.1 kg	17.9 lb 8.1 kg	20.6 lb 9.3 kg
Palletization Profile	8-units per layer 10/12 layer max 80/96 per pallet	4-units per layer 10-layer max. 40-units per pallet	8-units per layer 4-layer max. 32-units per pallet



Technical Specifications – Miscellaneous Features

Management Features

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button

Serviceability Features

- Dual colored power LED on front of computer to indicate either normal or fault condition
- Diagnostic LED Explanation Table:
 - Number of 1-second red LED blinks followed by a 2-second pause, then repeats:
 - 2 - processor thermal protection activated
 - 3 - processor not installed
 - 4 - power supply failure
 - 5 -- memory error
 - 6 - video error
 - 7 - PCA failure (ROM detected failure prior to video)
 - 8 - invalid ROM, boot block recovery mode
 - 9 - system not fetching code
 - 10 - system hang while loading an option ROM
- HP PC Hardware Diagnostics UEFI:
 - This utility enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support
- System/Emergency ROM
- Flash ROM
- CMOS Battery Holder for easy replacement
- Flash Recovery with Video Configuration Record Software
- 5 Aux Power LED on System PCA
- Processor ZIF Socket for easy Upgrade
- Over-Temp Warning on Screen (Requires IM Agents)
- Clear Password Jumper
- DIMM Connectors for easy Upgrade
- Clear CMOS Button
- NIC LEDs (integrated) (Green & Amber)
- Dual Color Power and HD LED - To Indicate Normal Operations and Fault Conditions
- Color coordinated cables and connectors
- Tool-less Hood Removal
- Front power switch
- System memory can be upgraded without removing the system board or any internal components
- Tool-less Hard Drive, CD & Diskette Removal
- Green Pull Tabs (SFF), and Quick Release Latches for easy Identification

Additional Features

Towerable Orientation

Product can be oriented as either a desktop (horizontal) or a tower (vertical)

Drive Lock

Implementation of the industry standard ATA Security feature set. When enabled, it prevents software access to user data on the drive until one or two user-defined passwords are provided.

DPS Access through F10 Setup during Boot

Drive Protection System

A diagnostic hard drive self-test. It scans critical physical components and every sector of the hard drive for physical faults and then reports any faults to the user

Running independently of the operating system, it can be accessed through a Windows-based diagnostics utility or through the computer's setup procedure. It



Technical Specifications – Miscellaneous Features

produces an evaluation on whether the hard drive is the source of the problem and needs to be replaced

The system expands on the Self-Monitoring, Analysis, and Reporting Technology (SMART), a continuously running systems diagnostic that alerts the user to certain types of failures

SMART Technology (Self-Monitoring, Analysis and Reporting Technology)

Allows hard drives to monitor their own health and to raise flags if imminent failures were predicted

SMART I - Drive Failure Prediction

Predicts failures before they occur. Tracks fault prediction and failure indication parameters such as re-allocated sector count, spin retry count, calibration retry count

SMART II - Off-Line Data Collection

By avoiding actual hard drive failures, SMART hard drives act as "insurance" against unplanned user downtime and potential data loss from hard drive failure

SMART III - Off-Line Read Scanning with Defect Reallocation

IOEDC: I/O Error Detection Circuitry

Detects errors in Read/Write buffers on HDD cache RAM

SMART IV - End-to-End CRC for hard drives

Interface in F10 setup provides confirmation of SMART IV support.



After-Market Options (availability may vary by region)

Business Monitors

	DM	SFF/MT	Part Number
HP ProDisplay P191	X	X	C9E54AA
HP ProDisplay P201	X	X	C9F26AA
HP ProDisplay P221	X	X	C9E49AA
HP ProDisplay P17A	X	X	F4M97AA
HP ProDisplay P19A	X	X	D2W67AA
HP ProDisplay P231	X	X	E4S07AA
HP EliteDisplay E201	X	X	C9V73AA
HP EliteDisplay E221	X	X	C9V76AA
HP EliteDisplay E231	X	X	C9V75AA
HP EliteDisplay E190i	X	X	E4U30AA
HP EliteDisplay E241i	X	X	F0W81AA
HP EliteDisplay E271i	X	X	D7Z72AA
HP EliteDisplay E221c	X	X	D9E49AA
HP EliteDisplay S230tm	X	X	E4S03AA
HP L2206tm	X	X	B0L55AA

Communication Devices

	DM	SFF/MT	Part Number
Intel Ethernet I210 – T1 Gbe NIC		X	E0X95AA
Intel 7260 802.11 a/b/g/n PCIe x1 WLAN Card	X	X	F2P07AA
HP WLAN 802.11 a/g/n 2x2 DualBand PCIe x1 Card		X	J5C51AA

Graphics Solutions

	DM	SFF/MT	Part Number
AMD Radeon HD 8350 Graphics (PCIe x16)		X	E1C63AA
AMD Radeon HD 8490 Graphics Card		X	E1C64AA
Nvidia NVS 310 Graphics (PCIe x16)		X	A7U59AA
Nvidia NVS 315 Graphics (PCIe x16)		X	E1C65AA
HP Dual Output USB Graphics Adapter	X	X	C5U89AA
HP USB Graphics Adapter	X	X	NL571AA
HP DisplayPort Cable Kit	X	X	VN567AA
HP DisplayPort To DVI-D Adapter	X	X	FH973AA
HP DisplayPort to HDMI Adapter	X	X	BP937AA
HP DisplayPort to VGA Adapter	X	X	AS615AA
HP DMS-59 to Dual DVI Cable		X	DL139A
HP DMS-59 to Dual DisplayPort Adapter		X	XP688AA
HP DVI to DVI Cable		X	DC198A

Data Storage Drives and Accessories

	DM	SFF/MT	Part Number
HP 500GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive		X	QK554AA
HP 1TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive		X	QK555AA
HP 1TB 10K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive		X	C2T91AA
HP 128GB SATA 3.0Gb/s Solid State Drive	X	X	QV063AA
Intel Pro 1500 180GB SATA SED Opal1 Solid State Drive	X	X	G4M04AA



After-Market Options (availability may vary by region)

HP 500GB SATA 3.0Gb/s Solid State Hybrid Drive	X	X	E1C62AA
HP 500GB 10K rpm SATA 3.5" Hard Disk Drive		X	C2T90AA
HP 128GB SED Opal 2 Solid State Drive	X		G1K24AA
HP Slim Removable SATA Hard Drive Enclosure (frame & carrier)		X	C1N41AA
HP Slim Removable SATA Hard Drive Enclosure (carrier only)		X	E3F39AA

Input Devices

	DM	SFF/MT	Part Number
HP USB Keyboard	X	X	QY776AA
HP USB Gray Keyboard	X	X	B6B64AA
HP USB Smart Card (CCID) Keyboard	X	X	BV813AA
HP USB Keyboard and Mouse Kit	X	X	B1T09AA
HP USB Washable Keyboard**	X	X	VF097AA
HP USB PS/2 Washable Mouse**		X	BM866AA
HP USB PS/2 Washable Keyboard and Mouse Kit**		X	BU207AA
HP PS/2 Mouse		X	QY775AA
HP PS/2 Keyboard		X	
HP USB Mouse	X	X	QY777AA
HP USB 1000dpi Laser Mouse	X	X	QY778AA
HP Wireless Keyboard and Mouse Combination*, **	X	X	QY449AA

*Keyboard contains 25% post-consumer recycled plastic material

** Low Halogen - External power supplies, power cords, cables and peripherals are not Low Halogen. Service parts obtained after purchase may not be Low Halogen.

System Memory

	DM	SFF/MT	Part Number
HP 4GB DDR3-1600 (PC3-12800) DIMM		X	B4U36AA
HP 8GB DDR3-1600 (PC3-12800) DIMM		X	B4U37AA
HP 4GB DDR3-1600 (PC3-12800) SODIMM	X		B4U39AA
HP 8GB DDR3-1600 (PC3-12800) SODIMM	X		B4U40AA

Multimedia Devices

	DM	SFF/MT	Part Number
HP Slim DVD-ROM Drive		X	VP033AA
HP Slim SuperMulti DVD Writer Drive		X	QS209AA
HP Slim BDXL Blu-Ray Writer Drive		X	E0X94AA
HP USB HD 720P v2 Business Webcam	X	X	D8Z08AA
HP Business Headset	X	X	QK550AA
HP USB Business Speakers	X	X	D9J19AA

Removable Media Storage

	DM	SFF/MT	Part Number
HP 15-in-1 USB2/3 3.5 Media Card Reader		X	F4N90AA

Security Devices

	DM	SFF/MT	Part Number
HP 2014 Solenoid Lock and Hood Sensor (SFF only)		SFF only	J6L43AA
HP 2014 Solenoid Lock and Hood Sensor (MT only)		MT only	J6L42AA



After-Market Options (availability may vary by region)

HP SFF Wall Mount/Security Sleeve		SFF only	VN570AA
HP UltraSlim Cable Lock	X	X	H4D73AA
HP Business PC Security Lock Kit		X	PV606AA

Stands and Accessories

	DM	SFF/TWR	Part Number
HP Integrated Work Center – Desktop Mini(IWCdm)	X		G1V61AA
HP Integrated Work Center Stand v3 (SFF)		SFF only	F2P06AA
HP SFF Tower Stand		SFF only	VN569AA
HP DM Chassis Tower Stand	X		G1K23AA
HP 800/600 SFF Bezel Kit		SFF only	E3F27AA
HP Serial Port Adapter (RS-232 compatible)		X	PA716A
HP Parallel Port Kit		X	KD061AA

LANDesk Software (E-Delivery)

Contact your HP representative for available options

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